# DataSheet

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# AS3977 Multi-Channel Narrowband FSK Transmitter

# 1 General Description

The AS3977 is a low-power fully integrated ETSI, FCC and ARIB compliant FSK transmitter capable of operating at any ISM frequency in the range of 300 to 928 MHz. It is based on a sigmadelta controlled fractional-N synthesizer phase locked loop (PLL) with fully integrated voltage controlled oscillator (VCO). The power amplifier (PA) output is programmable and can deliver power ranging from –20dBm up to +10dBm. An on-chip low drop-out (LDO) regulator is available in case an accurate output power independent of voltage supply variation is required. The output signal can be shaped using a programmable Gaussian filter to minimize the occupied bandwidth and adjacent channel power. The maximum data rate can be up to 100 kb/s – depending on the required filtering. The FSK frequency deviation is programmable up to a maximum of 64 kHz.

The crystal oscillator can handle a wide range of frequencies. For narrow-band applications, a temperature sensor with digital read-out is included that allows compensation of the crystal frequency drift due to temperature variation.

The AS3977 is connected to an external microcontroller via a bidirectional digital interface. The device operates at very low current consumption with a power supply range from 2.0V to 3.6V and can be powered down when not in use.

The device is fabricated in austriamicroystems advanced  $0.35 \mu m$  SiGe-BiCMOS technology.

# 2 Key Features

- Fully integrated UHF transmitter
- Compliant to ETSI EN 300-220, FCC CFR47 part 15 and ARIB STD-T67
- Multi-channel with narrow bandwidth
- 300 928 MHz operating frequency range (ISM)
- Filtered FSK
- Data rate up to 100 kb/s
- FSK deviation programmable up to 64kHz
- Extremely low power consumption

# Main Characteristics

- 2.0 3.6V power supply
- Power down current consumption 100 nA (3V, 25°C)
- Output power up to +10dBm
- Occupied bandwidth 6 kHz (4.8 kb/s, FFSK, ARIB)
- -40 to 85°C temperature range

# **Additional Features**

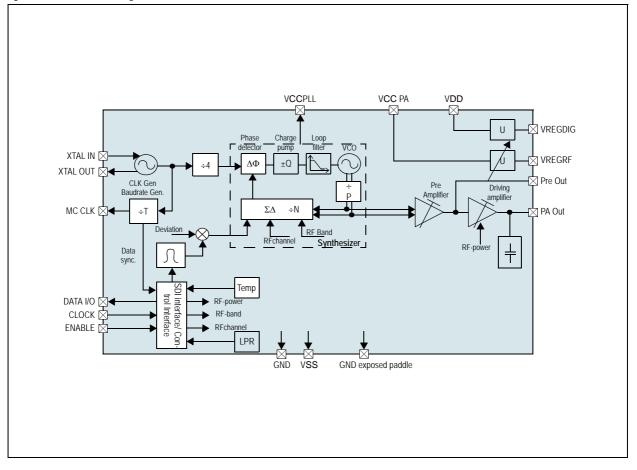
- Sigma-Delta controlled fractional-N synthesizer
- Resolution of synthesizer < 100Hz</li>
- Fully integrated PLL
- Fully integrated voltage controlled oscillator (VCO)
- 4kV ESD protection (1.5kV for the Analog pins)
- 12 20 MHz crystal oscillator
- On-chip temperature sensor with digital readout for AFC purposes
- Fast frequency hopping with predefined channel selection
- Microcontroller clock output to save addition crystal
- Constant output power over battery life time
- Integrated Manchester coder
- Digital lock detector
- Low drop-out regulator
- Bi-directional serial interface
- Low Power Down Mode current consumption

# 3 Applications

The AS3977 is suitable for Remote keyless entry systems, Short range radio data transmission, Domestic and consumer remote control units, Cordless alarm systems, Remote metering, and Low power telemetry.

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### Figure 1. AS3977 Block Diagram



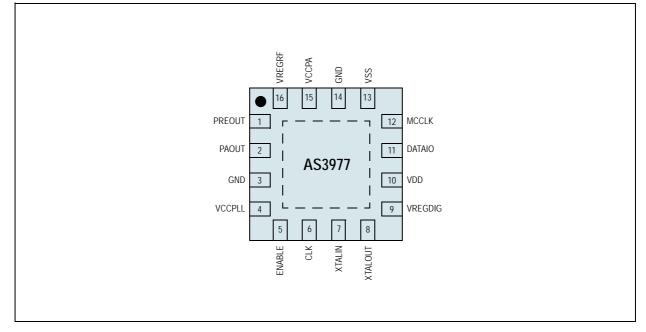
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# 4 Pin Assignments

Figure 2. Pin Assignments (Top View)



# 4.1 Pin Descriptions

## Table 1. Pin Descriptions

| Pin Name | Pin Number | Туре               | Description   |
|----------|------------|--------------------|---|
| PREOUT   | 1          | PREOUT             | Open Collector preamplifier output, need a feeding coil<br>connected to VREGRF or VDD and is the input for the Power<br>amplifier |
| PAOUT    | 2          | PREOUT             | Open Collector power amplifier output, need a feeding coil connected to VREGRF or VDD   |
| RESERVED | 3          |                    | Must be connected to GND  |
| VCCPLL   | 4          | Positive Power Pin | Positive supplies of VCO, for optimum performance, add decoupling capacitors on this Pin.   |
| ENABLE   | 5          |                    | Digital CMOS level input, internal Pull down resistor > 60k   |

Data Sheet - Pin Assignments



# Table 1. Pin Descriptions

| Pin Name | Pin Number | Туре               | Description   |
|----------|------------|--------------------|---|
| CLK      | 6          | CLK                | SDI clock   |
| XTALIN   | 7          |                    | XTAL oscillator input, DC Level approximately 1 Volt, needs an DC Blocker in case of external clock                                     |
| XTALOUT  | 8          |                    | XTAL oscillator output, DC Level approximately 1 Volt   |
| VREGDIG  | 9          |                    | Voltage regulator2 (VRegDig) output, requires a capacitor with nominal 100 nF.  |
| VDD      | 10         | Positive Power Pin | Positive supply of digital part and voltage regulator2 (VRegDig)  |
| DATAIO   | 11         | DATAIO             | Digital CMOS level input Pin, SDI data input / output   |
| MCCLK    | 12         | MCCCLK             | Micro controller clock output Digital output with variable driver strength  |
| VSS      | 13         | GND Pin            | Negative supply of digital part   |
| Reserved | 14         |                    | Must be connected to GND  |
| VCCPA    | 15         | Positive Power Pin | Positive supply of PA and voltage regulator   |
| VREGRF   | 16         |                    | Voltage regulator output to feed the RF Amplifier. For optimum performance a capacitor with nominal $1\mu$ F and 100 nF is recommended. |
| GND      | 17         | GND Power Pin      | Negative supply of analogue part (exposed paddle)   |
| -        | •          |                    |   |

# 5 Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated under "Operating Conditions" (see Table 3) is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

| Tahla 2  | Absolute Maximum      | Datinac |
|----------|-----------------------|---------|
| IADIC Z. | Αυσυμίε Ινιαλιπμίπη Ι | Naunus  |

| Paran   | neter                                     | Min  | Max | Units | Comments   |
|---|---|------|-----|-------|--|
| Positive supply                               | voltage (V <sub>SUP</sub> )               | -0.5 | 5.0 | V     | Voltage on all supply Pins VCCPA, VCCPLL, VDD  |
| Negative supply vo                            | Negative supply voltage (GND, Vss)        |      | 0   | V     |  |
| Input current (latch-                         | up immunity) (I <sub>SCR</sub> )          | -40  | 40  | mA    | Norm: Jedec 17   |
| ESD for Digital Pins                          | ESD <sub>DHBM</sub>                       | ±4   |     | kV    | Norm MIL 883 E method 3015<br>(Human Body Model)   |
|   | ESD <sub>DMM</sub>                        | ±200 |     | V     | Norm: EIJA IC-121<br>(Machine Model)   |
| ESD for Analog Pins                           | ESD <sub>AHBM</sub>                       | ±1.5 |     | kV    | Norm MIL 883 E method 3015<br>(Human Body Model)   |
| LOD TOT Analog Fills                          | ESD <sub>AMM</sub>                        | ±100 |     | V     | Norm: EIJA IC-121<br>(Machine Model)   |
| ESD for RF Pins                               | ESD <sub>RFHBM</sub>                      | ±1.5 |     | kV    | Norm MIL 883 E method 3015<br>(Human Body Model)   |
|   | ESD <sub>RFMM</sub>                       | ±100 |     | V     | Norm: EIJA IC-121<br>(Machine Model)   |
| Total power<br>(all supplies                  |   |      | 200 | mW    |  |
| Storage temper                                | Storage temperature, (T <sub>STRG</sub> ) |      | 125 | °C    |  |
| Package body temperature (T <sub>BODY</sub> ) |   |      | 260 | ٥C    | Norm: IPC/JEDEC J-STD-020C.<br>The reflow peak soldering temperature (body<br>temperature) specified is in accordance with IPC/<br>JEDEC J-STD-020C "Moisture/Reflow Sensitivity<br>Classification for Non-Hermetic Solid State Surface<br>Mount Devices". |
| Humidity non                                  | -condensing                               | 5    | 85  | %     |  |

# 6 Electrical Characteristics

Table 3. Operating Conditions

| Symbol           | Parameter                       | Conditions                                | Min  | Тур | Мах | Units |
|------------------|---------------------------------|---|------|-----|-----|-------|
| V <sub>SUP</sub> | Positive supply voltage analog  | Voltage on all supply<br>VCCPA,VCCPLL,VDD | 2.0  |     | 3.6 | V     |
| GND              | Negative supply voltage analog  |   | 0    |     | 0   | V     |
| Vss              | Negative supply voltage digital |   | 0    |     | 0   | V     |
| A-D              | Difference of supplies          | VCC-VDD, GND-VSS                          | -0.1 |     | 0.1 | V     |
| Тамв             | Ambient Temperature             |   | -40  |     | 85  | ٥C    |

Table 4. Block Specification

| Symbol               | Parameter   | Conditions   | Min   | Тур  | Мах | Units    |
|----------------------|---|--|-------|------|-----|----------|
| fout315              |   |  | 300   |      | 320 |          |
| fout434              | Output Frequency Dense                                  |  | 425   |      | 450 |          |
| f <sub>OUT868</sub>  | - Output Frequency Range                                |  | 865   |      | 870 | - MHz    |
| fout915              |   |  | 902   |      | 928 |          |
| P <sub>OUT</sub>     | Output Power  | Depends on Power Setting   |       |      |     |          |
| frout                | FSK Data Rate   | Internal Manchester Coding   | 1     |      | 100 | - kbit/s |
| f <sub>FSKdata</sub> | T SK Dala Kale  | Internal Manchester Coung  | 0.5   |      | 50  | - KUIUS  |
| 315MHz Fi            | equency Band Section, FCC part 15 is                    | applicable   |       |      |     |          |
| $\Delta FSK_1$       | FSK Deviation   | programmable (8bit)<br>Resolution of FSK Deviation (see Table 5)   | 0     |      | ±64 | kHz      |
|                      | Spurious Emissions                                      | 216-960MHz   |       |      | -49 |          |
| P <sub>SPE1</sub>    | (max. –19.6dBm radiated fundamental power) <sup>1</sup> | at frequencies > 960Mhz<br>at harmonics  |       |      | -41 | dBm      |
|                      |   |  |       |      | -40 |          |
|                      | Phase noise @ 50 kHz                                    | Charge pump setting: I <sub>CHP</sub> =50µA;   |       | -86  |     |          |
|                      | Phase noise @ 250 kHz                                   | V <sub>SUP</sub> =2.03.6V,<br>TAMB=-4085°C   |       | -92  |     | dBc/Hz   |
|                      | Phase noise @ 1 MHz                                     |  |       | -102 |     |          |
| 434MHz Fi            | equency Band Section, EN 300 220 ar                     | nd/or ARIB STD-T67 are applicable  |       |      |     |          |
| $\Delta FSK_2$       | FSK Deviation   | Small deviation (ARIB), programmable (8bit)  | ±1.25 |      | ±4  | - 647    |
|                      |   | Resolution of FSK Deviation (see Table 5)  | 0     |      | ±64 | kHz<br>ł |
|                      | Phase noise @ 50 kHz                                    | Charge pump setting: I <sub>CHP</sub> =50µA;   |       | -86  | -83 |          |
|                      | Phase noise @ 250 kHz                                   | V <sub>SUP</sub> =2.03.6V,   |       | -94  |     | dBc/Hz   |
|                      | Phase noise @ 1 MHz                                     | Тамв=-40…85°С  |       | -102 |     |          |
| P <sub>ACP2</sub>    | Adjacent Channel Power                                  | ARIB, f <sub>REF</sub> =4MHz, I <sub>CHP</sub> =50µA   |       |      | -40 | dBc      |
|                      |   | Channel spacing 12.5 kHz, FSK data rate<br>4.8 kbit/s (ARIB)<br>FSK Deviation ±1.8 KHz   |       |      | 8.5 |          |
| OBW <sub>2</sub>     | Occupied Bandwidth                                      | GF Setting (see Gaussian Filter Clock<br>Setting on page 38)<br>Channel spacing 25 kHz,<br>FSK data rate 9.6 kbit/s (ARIB)<br>FSK Deviation ±3.0 KHz | 8.5   |      | 16  | kHz      |

#### Table 4. Block Specification (Continued)

| Symbol            | Parameter  | Conditions   | Min | Тур | Max | Units  |
|-------------------|--|--|-----|-----|-----|--------|
| P <sub>SPE2</sub> | Spurious Emissions<br>excluding Harmonics <sup>1</sup> | 47-74MHz<br>87.5-118MHz<br>174-230MHz<br>470-862MHz (EN 300 220)             |     |     | -54 | dBm    |
|                   | Spurious Emissions                                     | at other frequencies < 1GHz  |     |     | -36 |        |
|                   | and Harmonics <sup>1</sup>                             | at ≥ 1GHz (EN 300 220)   |     |     | -30 | dBm    |
|                   |  | ARIB   |     |     | -29 |        |
| ferror            | Output Frequency Error                                 | With ideal crystal,<br>V <sub>SUP</sub> =2.0…3.6V,<br>TAMB=-40…85°C          |     |     | ±1  | ppm    |
| 868MHz Fr         | equency Band Section, EN 300 220 is                    | applicable   |     |     |     |        |
| $\Delta FSK_3$    | FSK Deviation  | programmable (8bit)<br>Resolution of FSK Deviation (see Table 5)             | 0   |     | ±64 | kHz    |
| P <sub>SPE3</sub> | Spurious Emissions<br>excluding Harmonics <sup>1</sup> | 47-74MHz<br>87.5-118MHz<br>174-230MHz<br>470-862MHz (@-10dBm radiated power) |     |     | -54 | dBm    |
|                   | Spurious Emissions                                     | at other frequencies < 1GHz  |     |     | -36 | dDma   |
|                   | and Harmonics <sup>1</sup>                             | at frequencies $\geq$ 1GHz   |     |     | -30 | dBm    |
|                   | Phase noise @ 50 kHz                                   | Charge pump setting: I <sub>CHP</sub> =50µA;                                 |     |     | -78 |        |
|                   | Phase noise @ 250 kHz                                  | V <sub>SUP</sub> =2.03.6V,   |     |     | -85 | dBc/Hz |
|                   | Phase noise @ 1 MHz                                    | Тамв=-4085°С   |     |     | -89 | -      |
| 915MHz Fr         | equency Band Section, FCC part 15 is                   | applicable   |     |     |     |        |
| $\Delta FSK_4$    | FSK Deviation  | programmable (8bit)<br>Resolution of FSK Deviation (see Table 5)             | 0   |     | ±64 | kHz    |
|                   | Spurious Emissions                                     | 216-960MHz   |     |     | -49 |        |
| P <sub>SPE4</sub> | (max. –1dBm radiated fundamental power) <sup>1</sup>   | at frequencies > 960MHz and harmonics  |     |     | -41 | dBm    |

1. These parameters will not be tested.

#### Table 5. Resolution of FSK Deviation

| Symbol               | Parameter                                | Conditions  | Equation for Min. Resolution                        | Units |  |  |  |  |  |  |  |
|----------------------|--|---|---|-------|--|--|--|--|--|--|--|
| 315MHz and           | 315MHz and 434MHz Frequency Band Section |   |   |       |  |  |  |  |  |  |  |
| ∆FSK <sub>res1</sub> | Resolution of FSK Deviation <sup>1</sup> | For detailed information, See FSK<br>Deviation Setting and Frequency<br>Trimming on page 37 | $\Delta F = (INT < 8 > +1). \frac{f_{REF}}{2^{16}}$ | Hz    |  |  |  |  |  |  |  |
| 868MHz and           | 1915MHz Frequency Band Section           |   |   |       |  |  |  |  |  |  |  |
| ∆FSK <sub>res2</sub> | Resolution of FSK Deviation <sup>1</sup> | For detailed information, See FSK<br>Deviation Setting and Frequency<br>Trimming on page 37 | $\Delta F = (INT < 8> +1). \frac{f_{REF}}{2^{15}}$  | Hz    |  |  |  |  |  |  |  |

### 1. INT<8> refer to Register Settings

### Table 6. Reference Frequency Generator and Micro Controller Clock Driver

| Symbol     | Parameter | Conditions | Min | Тур | Мах | Units |
|------------|-----------|------------|-----|-----|-----|-------|
| Crystal Os | cillator  |            |     |     |     |       |

| Symbol             | Parameter  | Conditions  | Min                  | Тур | Мах                  | Units |
|--------------------|--|---|----------------------|-----|----------------------|-------|
| f <sub>XOSC</sub>  | Crystal Oscillator Frequency                     |   | 12                   | 16  | 20                   | MHz   |
| t <sub>xosc</sub>  | Crystal Oscillator Start up time                 | $V_{SUP}=2.03.6V$ ,<br>TAMB=-4085°C<br>crystal series resistance $\leq 100\Omega$ |                      |     | 1.5                  | ms    |
| R <sub>XOSC</sub>  | Crystal Oscillator Oscillation Margin<br>Level   | f <sub>XOSC</sub> =13.56MHz, C <sub>L</sub> =12pF                                 | 1500                 |     |                      | Ω     |
| $\Delta f/f_0$     | Frequency Stability vs. Temperature <sup>1</sup> | AS3977 Only   |                      |     | ±1                   | ppm   |
| Micro Cont         | roller Clock Driver                              |   |                      |     |                      |       |
| f <sub>MCCLK</sub> | Clock output frequency                           | depending on configuration register settings and crystal                          |                      |     | 4                    | MHz   |
| V <sub>MCL</sub>   | Low level output voltage                         | V <sub>SUP</sub> =3V, at nominal high level output current                        |                      |     | 0.1*V <sub>SUP</sub> | V     |
| V <sub>MCH</sub>   | High level output voltage                        | V <sub>SUP</sub> =3V, at nominal high level output current                        | 0.9*V <sub>SUP</sub> |     |                      | V     |
| CLMCC              | Capacitive load                                  |   |                      |     | 20                   | pF    |
| t <sub>RMCC</sub>  | Rise time  |   |                      |     | 62.5                 | ns    |
| t <sub>FMCC</sub>  | Fall time  |   |                      |     | 62.5                 | ns    |
| I <sub>MCH</sub>   | High level output current                        |   |                      |     | 1                    | mA    |
| I <sub>MCL</sub>   | Low level output current                         |   |                      |     | 1                    | mA    |

## Table 6. (Continued)Reference Frequency Generator and Micro Controller Clock Driver

#### 1. These parameters will not be tested.

### Table 7. Phase Locked Loop

| Symbol            | Parameter                   | Conditions   | Min | Тур | Мах | Units |
|-------------------|-----------------------------|--|-----|-----|-----|-------|
| f <sub>REF</sub>  | Comparison Frequency        | depending on f <sub>XOSC</sub><br>(reference divider division ratio = 4) | 3.0 | 4.0 | 5.0 | MHz   |
| Afo               | Output Frequency Decolution | tput Frequency Resolution four315 / four434<br>four868 / four915         | 46  | 61  | 77  | Hz    |
| $\Delta f_{O}$    |                             |  | 92  | 122 | 153 | ΠZ    |
| <b>t</b> SYNTH    | Synthesizer Start up Time   |  |     | 500 |     | μs    |
| t <sub>LOCK</sub> | Synthesizer Lock Time       | $\Delta f$ =600kHz,<br>f <sub>ERROR</sub> @ t <sub>LOCK</sub> =10kHz     |     | 50  | 200 | μs    |

### Table 8. Loop Filter Bandwidth

| Symbol          | Parameter                   |           | Conditions                   | Min | Тур | Мах | Units |  |  |  |
|-----------------|-----------------------------|-----------|------------------------------|-----|-----|-----|-------|--|--|--|
| Filter Band     | Filter Bandwidth at 315 MHz |           |                              |     |     |     |       |  |  |  |
|                 |                             | @ 12.5 µA |                              |     | 55  |     |       |  |  |  |
| f               | ICHP                        | @ 25 µA   | Reference Frequency = $4MHz$ |     | 85  |     | 6117  |  |  |  |
| f <sub>BW</sub> |                             | @ 37.5µA  | VSUP = 3.0 V;<br>TAMB = 25°C |     | 115 |     | kHz   |  |  |  |
|                 |                             | @ 50 µA   |                              |     | 170 |     |       |  |  |  |
| Filter Band     | Filter Bandwidth at 433 MHz |           |                              |     |     |     |       |  |  |  |

### Table 8. (Continued)Loop Filter Bandwidth

| Symbol          | Paramet              | er        | Conditions                                  | Min | Тур | Мах | Units |
|-----------------|----------------------|-----------|---|-----|-----|-----|-------|
|                 |                      | @ 12.5 µA |   |     | 50  |     |       |
| f <sub>BW</sub> | Charge pump setting: | @ 25 µA   | Reference Frequency = 4MHz<br>VSUP = 3.0 V; |     | 70  |     | kHz   |
| IBM             | I <sub>CHP</sub>     | @ 37.5µA  | VSOP = 3.0 V,<br>ТАМВ = 25°С                |     | 90  |     | КПД   |
|                 |                      | @ 50 µA   |   |     | 120 |     |       |
| Filter Band     | width at 868 MHz     |           |   |     |     |     |       |
|                 |                      | @ 12.5 µA |   |     | 50  |     |       |
| f <sub>BW</sub> | Charge pump setting: | @ 25 µA   | Reference Frequency = 4MHz<br>VSUP = 3.0 V; |     | 70  |     | kHz   |
| IBM             | I <sub>CHP</sub>     | @ 37.5µA  | VSOP = 3.0 V,<br>ТАМВ = 25°С                |     | 90  |     | КПД   |
|                 | (                    | @ 50 µA   |   |     | 120 |     |       |

| Symbol | Parameter   | Conditions  | Min  | Тур            | Мах  | Units |
|--------|---|---|------|----------------|------|-------|
| Роит   | Min. Output Power @ 50 $\Omega$                               | Vsup=3V, @ 25°C,<br>Power depending on power setting with or<br>without the use of the internal voltage<br>regulator, external matching network<br>included                                 |      | -20            |      | dBm   |
| Роит   | Max. Output Power @ 50 $\Omega$                               | VsuP=3V, @ 25°C,<br>Power depending on power setting with or<br>without the use of the internal voltage<br>regulator, external matching network<br>included                                 |      | 8              |      | dBm   |
| Роит   | Output Power<br>Variation@ 50Ω <sup>1</sup><br>(300 – 320MHz) | Vsup=3V, @ 25°C,<br>Power depending on register setting with<br>or without the use of the internal voltage<br>regulator,<br>external matching network included,<br>strong AB operation mode | -2.5 |                | +2.5 | dBm   |
| Роит   | Output Power<br>Variation@ 50Ω <sup>1</sup><br>(425 – 450MHz) | Vsup=3V, @ 25°C,<br>Power depending on register setting with<br>or without the use of the internal voltage<br>regulator,<br>external matching network included,<br>strong AB operation mode | -2.0 |                | +2.0 | dBm   |
| Роит   | Output Power Variation vs. VDD and<br>Temperature @ 50Ω       | VSUP=2.23.6V, TAMB=-4085°C, With<br>the use of the internal voltage regulator,<br>external matching network included,<br>strong AB operation mode   | -2.8 | +0.6 /<br>-1.5 | 1.0  | dB    |
| Роит   | Output Power Variation vs.<br>Temperature @ 50Ω               | VSUP=3V, TAMB=-4085°C,<br>Without the use of the internal voltage<br>regulator,<br>external matching network included,<br>strong AB operation mode  |      | +1.5 /<br>-2.0 |      | dB    |
| Роит   | Max Output Power @ 50 $\Omega$                                | VsuP=3.6V, @ 25°C,<br>Power depending on power setting<br>without the use of the internal voltage<br>regulator,<br>external matching network included                                       |      | 10             |      | dBm   |

1. Limits by production test measurement uncertainties

| Symbol | Parameter   | Conditions  | Min  | Тур            | Мах  | Units |
|--------|---|---|------|----------------|------|-------|
| Роит   | Min Output Power<br>@ 50Ω                               | VSUP=3V, @ 25°C,<br>Power depending on power setting with or<br>without the use of the internal voltage<br>regulator,<br>external matching network included   |      | -20            |      | dBm   |
| Роит   | Max Output Power<br>@ 50Ω                               | VSUP=3V, @ 25°C,<br>Power depending on power setting with or<br>without the use of the internal voltage<br>regulator, external matching network<br>included   |      | 4              |      | dBm   |
| Роит   | Output Power Variation @ 50 $\Omega^1$                  | VSUP=3V, @ 25°C,<br>Power depending on register setting with<br>or without the use of the internal voltage<br>regulator, external matching network<br>included, strong AB operation mode <sup>2</sup> | -3.5 |                | +3.5 | dBm   |
| Роит   | Output Power Variation vs. VDD and<br>Temperature @ 50Ω | VSUP=2.23.6V,<br>TAMB= -4085°C,<br>With the use of the internal voltage<br>regulator, external matching network<br>included, strong AB operation mode <sup>2</sup>                                    |      | +2.0 /<br>-3.0 |      | dB    |
| Роит   | Output Power Variation vs.<br>Temperature @ 50Ω         | VSUP=3V,<br>TAMB=-4085°C,<br>Without the use of the internal voltage<br>regulator, external matching network<br>included, strong AB operation mode <sup>2</sup>                                       |      | +2.0 /<br>-3.0 |      | dB    |

1. Limits by production test measurement uncertainties

2. Power line matching needs to be adjusted to VDD to ensure strong AB operation mode

Table 11. Antenna Tuning Circuit

| Symbol             | Parameter                        | Conditions         | Min | Тур  | Мах | Units |
|--------------------|----------------------------------|--------------------|-----|------|-----|-------|
| C <sub>Atmin</sub> | Minimum Antenna tuning Capacitor | ATCPH <3:0> = 0000 |     | 0.11 |     | pF    |
| C <sub>Atmax</sub> | Maximum Antenna tuning Capacitor | ATCPH <3:0> = 1111 |     | 1.51 |     | pF    |

Table 12. Low Power Reset (Bit LT)

| Symbol           | Parameter                                | Conditions                | Min  | Тур  | Мах  | Units |
|------------------|--|---------------------------|------|------|------|-------|
| V <sub>LPR</sub> | Low Power Detection Threshold<br>Voltage | Decreasing Supply Voltage | 1.85 | 1.95 | 2.05 | V     |
| V <sub>LPR</sub> | Low Power Release Threshold<br>Voltage   | Rising Supply Voltage     |      | 2.05 |      | V     |

#### Table 13. Low Supply Voltage Detector (Bit LS)

| ſ | Symbol          | Parameter                                 | Conditions                | Min | Тур  | Мах | Units |
|---|-----------------|---|---------------------------|-----|------|-----|-------|
|   | $V_{\text{LS}}$ | Low Supply Detection Threshold<br>Voltage | Decreasing Supply Voltage | 2.0 | 2.1  | 2.2 | V     |
|   | V <sub>LS</sub> | Low Supply Release Threshold<br>Voltage   | Rising Supply Voltage     |     | 2.17 |     |       |

### Table 14. Temperature Sensor

| Symbol             | Parameter                                  | Conditions  | Min | Тур  | Мах                   | Units    |
|--------------------|--|---|-----|------|-----------------------|----------|
| ERR <sub>TS</sub>  | Absolute Error                             | Tamb = -4085°C  | -5  |      | +5                    | ٥C       |
| ERR <sub>TSL</sub> | Absolute Error (limited temperature range) | Тамв = -2065°С  |     | ±2   |                       | °C       |
|                    | Conversion Factor                          | Tamb = -4085°C  |     | 0.19 |                       | °C/bit   |
| OR <sub>TS</sub>   | Output Resolution                          |   |     | 10   |                       | bit      |
| CR <sub>TS</sub>   | Conversion Rate                            | $f_{TS} = f_{CRYSTAL}/12$<br>after startup time of 256 / $f_{TS}$ |     |      | f <sub>TS</sub> /1354 | samples/ |

Table 15. Voltage Regulator for Power Amplifier

| Symbol       | Parameter                                    | Conditions                | Min   | Тур | Мах | Units |
|--------------|--|---------------------------|-------|-----|-----|-------|
| VREGRF       | Output Voltage for supply Power<br>Amplifier | Adjustable, nominal value | 1.7   |     | 2.0 | V     |
| D_VREGR<br>F | Regulator Tolerance                          |                           | -0.15 |     | 0.1 | V     |

Table 16. Current Consumption

| Symbol                 | Parameter   | Conditio                                  | Min                                    | Тур | Мах  | Units |    |  |
|------------------------|---|---|--|-----|------|-------|----|--|
|                        |   | VSUP=3V @ 25°C                            |  |     | 100  | 250   |    |  |
| Ipdwn                  | Power Down Mode   | Vsup=2.03.6V,<br>Тамв=-4085°С             |  |     | 1000 | 5000  | nA |  |
|                        |   | VSUP=3V @<br>C <sub>load</sub> ≤20pF, fcL |  |     | 1    | 1.25  |    |  |
| I <sub>CLKEN</sub>     | Clock Enable Mode   | VSUP=2.0<br>Тамв=-4085°С,<br>fclk=20N     | Cload≤20pF,                            |     | 1.25 | 1.6   | mA |  |
| I <sub>Temp_sens</sub> | Temperature sensor Current  | Vsup=2.03.6V,<br>Тамв=-4085°С             |  |     | 0.25 |       | mA |  |
| I <sub>PLLEN</sub>     | PLL Enable Mode   | Vsup=2.03.6V,<br>Тамв=-4085°С             |  |     | 5.6  |       | mA |  |
|                        |   | VSUP=3V @ 25°C                            | without the use of                     |     | 13.5 | 16.5  | mA |  |
| ITX8dBm <sub>31</sub>  | Transmit Mode @ 8dBm output<br>power,<br>315 MHz band @ 50Ω including | VSUP=2.03.6V,<br>TAMB=-4085°C             | the internal regulator <sup>1</sup>    |     | 15.5 | 19    | mA |  |
| 5                      | matching network, strong AB   | VSUP=3V @ 25°C                            | with the use of the                    |     | 14.0 | 17.0  | mA |  |
|                        | operation   | VSUP=2.23.6V,<br>Tamb=-4085°C             | internal regulator                     |     | 16.0 | 19.5  | mA |  |
|                        |   | VSUP=3V @ 25°C                            | without the use of                     |     | 12.5 | 15.5  | mA |  |
| ITX8dBm <sub>43</sub>  | Transmit Mode @ 8dBm output<br>power,<br>422 MUz band @ 500 including | VSUP=2.03.6V,<br>Tamb=-4085°C             | the internal regulator                 |     | 14.5 | 18    | mA |  |
| 3                      | matching network, strong AB   | VSUP=3V @ 25°C                            |  |     | 13.0 | 16.0  | mA |  |
|                        | operation   | VSUP=2.23.6V,<br>TAMB=-4085°C             | with the use of the internal regulator |     | 15   | 18.5  | mA |  |

### Table 16. Current Consumption

| Symbol                | Parameter  | Conditio                               | Min                    | Тур  | Мах  | Units |    |
|-----------------------|--|--|------------------------|------|------|-------|----|
|                       |  | VSUP=3V @ 25°C                         | without the use of     |      | 14.5 | 17.5  | mA |
| ITX4dBm <sub>86</sub> | X4dBm <sub>86</sub> 868 MHz and 906MHz band @     VSUP=2.03.0V,<br>TAMB=-4085°C     rec       8     50Ω including matching<br>network, strong AB operation     VSUP=3V @ 25°C     with the | 1001 2.00.01                           | the internal regulator |      | 16.5 | 19.0  | mA |
| 8                     |  | VSUP=3V @ 25°C                         | with the use of the    |      | 15.0 | 18.0  | mA |
|                       |  | with the use of the internal regulator |                        | 17.0 | 19.5 | mA    |    |

1. Power line matching needs to be adjusted to VDD to ensure strong AB operation mode

Table 17. DC/AC Characteristics for Digital Interface

| Symbol         | Parameter   | Conditions                                       | Min                   | Тур       | Мах            | Units      |
|----------------|---|--|-----------------------|-----------|----------------|------------|
| CMOS Inpu      | ut  |  |                       |           |                |            |
| Viн            | High Level Input Voltage  |  | 0.7 *<br>Vsup         |           | VSUP +<br>0.1  | V          |
| Vil            | Low Level Input Voltage   |  | V <sub>GND</sub> -0.1 |           | 0.3 * VSUP     | V          |
| lı∟            | Low Level Input Leakage Current   | no internal pull up/down                         |                       |           | ±1             | μA         |
| Ін             | High Level Input Leakage Current  | no internal pull up/down                         |                       |           | ±1             | μA         |
| lihpd          | High Level Input Leakage Current with<br>internal pull down                     | VSUP=3.6V, VIN=3.6V                              | 15                    |           | 60             | μA         |
|                | ne following specification is valid for the D rengths according MCCDS register. | ATAIO standard CMOS output. The MCCL             | K output can          | be progra | mmed to differ | ent driver |
|                |   | ATAIO standard CMOS output. The MCCL             | K output can          | be progra | mmed to differ | ent driver |
| Voн            | High level output voltage   | VSUP=3V, at nominal high level output<br>current | VSUP-0.5              |           |                | V          |
| Vol            | Low level output voltage  | VSUP=3V, at nominal low level output<br>current  |                       |           | Vss+0.4        | V          |
| CL             | Capacitive load   |  |                       |           | 20             | pF         |
| t <sub>R</sub> | Rise time   |  |                       |           | 50             | ns         |
| t <sub>F</sub> | Fall time   |  |                       |           | 50             | ns         |
| ЮН             | High level output current   |  |                       |           | 1              | mA         |
| lol            | Low level output current  |  |                       |           | 1              | mA         |

# 7 Timing Characteristics

Be aware that the Power Down Mode can be entered by setting ENABLE low for more than 2<sup>16</sup> XTAL cycles (Power Down Timer).

Figure 3. Write Data

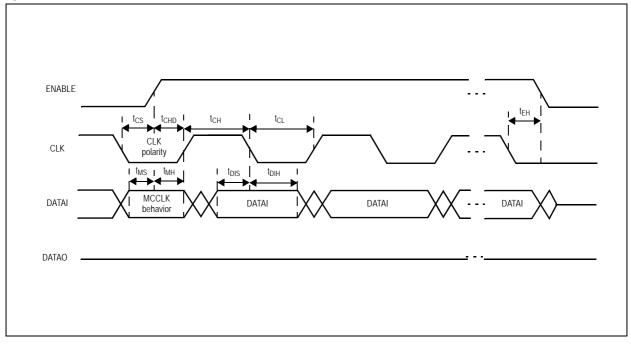
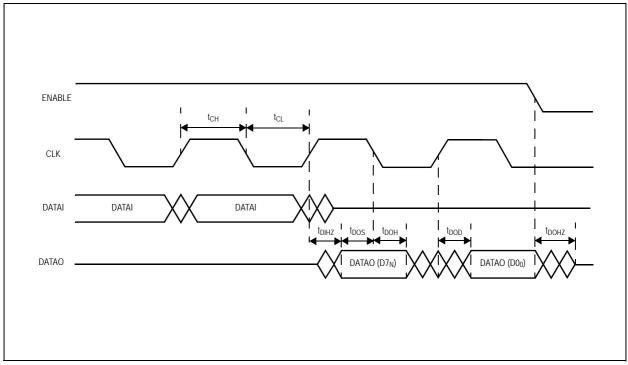


Figure 4. Read Data



# 7.1 Timing Parameters

Table 18. Timing Parameters

| Symbol            | Parameter                              | Condition   | Min       | Тур  | Max | Units |
|-------------------|--|---|-----------|------|-----|-------|
| General           |  |   |           |      |     |       |
| BR <sub>SDI</sub> | Bit rate                               |   |           |      | 2   | Mbps  |
| tсн               | Clock high time                        |   | 250       |      |     | ns    |
| tCL               | Clock low time                         |   | 250       |      |     | ns    |
| Write timing      |  |   |           |      |     |       |
| t <sub>DIS</sub>  | Data in setup time                     |   | 20        |      |     | ns    |
| t <sub>DIH</sub>  | Data in hold time                      |   | 10        |      |     | ns    |
| t <sub>EH</sub>   | Enable hold time                       |   | 20        |      |     | ns    |
| Read timing       |  |   |           | •    |     | •     |
| t <sub>DIHZ</sub> | Data in to high impedance delay        | time for the $\mu C$ to release the DATAIO bus          |           |      | 45  | ns    |
| t <sub>DOS</sub>  | Data out setup time                    |   | 130       |      |     | ns    |
| t <sub>DOH</sub>  | Data out hold time                     |   | 135       |      |     | ns    |
| t <sub>DOD</sub>  | Data out delay                         |   |           |      | 80  | ns    |
| t <sub>DOHZ</sub> | Data out to high impedance delay       | time for the SDI to release the DATAIO bus              |           |      | 80  | ns    |
| Timing param      | neters when leaving the Power Down Mod | e (for determination of CLK polarity and MC             | CLK behav | ior) |     | •     |
| tcs               | Clock setup time<br>(CLK polarity)     | Setup time of CLK with respect to<br>ENABLE rising edge | 20        |      |     | ns    |
| t <sub>CHD</sub>  | Clock hold time<br>(CLK polarity)      | Hold time of CLK with respect to ENABLE rising edge     | 20        |      |     | ns    |
| t <sub>MS</sub>   | Data in setup time<br>(MCCLK behavior) | DATAIO setup time with respect to<br>ENABLE rising edge | 20        |      |     | ns    |
| t <sub>MH</sub>   | Data in hold time<br>(MCCLK behavior)  | DATAIO hold time with respect to<br>ENABLE rising edge  | 20        |      |     | ns    |

# 8 Detailed System Description

The AS3977 is based on a fully integrated sigma-delta controlled fractional-N synthesizer phase locked loop (PLL) and a power amplifier (PA). A reference frequency generator including a crystal oscillator provides the comparison frequency of the PLL and a high-precision clock output. A programmable Gaussian filter enables to minimize the occupied bandwidth and adjacent channel power. A temperature sensor with digital readout is included that allows compensation of the crystal frequency drift due to temperature variation. An on-chip low drop out regulator (LDO) is available in case an accurate output power independent of supply voltage variation is required. A second LDO for the digital supply voltage helps to minimize interference between the analog and digital part and decreases the current consumption of the digital part. A PROM enables the compensation of process variation. The AS3977 is controlled by an external microcontroller via a bi-directional serial digital interface (SDI).

# 8.1 Reference Frequency Generator

The reference frequency generator consists of a crystal oscillator and frequency divider. The crystal oscillator can be driven externally in case an external clock frequency is supplied.

# 8.2 Phase Locked Loop

The PLL is of standard charge pump type. The phase frequency detector is designed such that dead zone problems are avoided. The charge pump current is programmable. All loop filter components are on-chip, the bandwidth is programmable through the charge pump current. The differential based voltage controlled oscillator (VCO) has integrated inductors and varactors. The VCO operates at a center frequency around 1.8GHz. To cover the specified frequency range over process variation, the sufficiently wide overall tuning range is split into 16 overlapping frequency bands. At start up of the PLL, an automatic range select circuit (ARS) selects the proper frequency band. The VCO output frequency is divided by 2, 4, and 6, which enables to cover output frequencies in the range of 850 – 928 MHZ, 425 – 450 MHz and 300 – 320 MHz, respectively. A lock detector enables to monitor the PLL lock status.

# 8.3 Gaussian Filter and Digital Modulator

The programmable sigma-delta modulator controls the output frequency of the PLL. The order of the modulator is programmable (MASH2 or MASH3). In combination with the programmable Gaussian filter for the data signal, the modulator performs the FSK modulation with programmable deviation, whereby the Gaussian Filter enables to minimize the occupied bandwidth and the adjacent channel power.

# 8.4 Power Amplifier

The power amplifier is single ended and consists of a preamplifier and an output stage, both with open collector. The necessary external chokes can be connected to a LDO in case an accurate output power independent of supply voltage variation is required. The output power is programmable up to 10dBm.

## 8.5 Temperature Sensor

The AS3977 includes a temperature sensor to measure the absolute temperature inside the chip. The analog value is converted to a digital value and can then be read out by the microcontroller in order to control the output frequency and/or the transmission power. The value of the chip temperature in degree can be obtained using following formula:

Temperature = 
$$TS < 9...0 > * 0.19 - 50$$
 (EQ 1)

The temperature sensor can be used to compensate the crystal drift over temperature.

**Note:** AS3977 has the same temperature than the crystal only at start up and the temperature will increase immediately thereafter due to self heating.

Temperature sensor must be used only in the Clock Enable Mode as a stand alone block. It is mandatory to be used with the PLL and Power Amplifier switched off.

## 8.6 Low Power Reset

The low power reset (LPR) disables the power amplifier, if the supply voltage falls below the low power threshold.

## 8.7 Low Drop Out Regulators

In order to avoid stability issues, external capacitors are required. (see Table 1)

# 8.8 SDI / Control Interface

This interface enables a serial and synchronous communication between external microcontroller and AS3977. Data can be written to and read out from AS3977. Additionally, it facilitates the transmission of TX-data. The rising edge on the SDI enable signal (transition to the active state), while the device is in Power Down Mode has various effects on the circuit:

- It wakes up the crystal oscillator (this takes maximum 1.5 ms with the specified Crystal parameters)
- It sets the transfer and sampling edge of the AS3977 SDI data signal.
- It activates the Micro Controller clock output depending on the register setting and the value of the data signal.

Thus, the wakeup event through the SDI interface determines the basic communication between AS3977 and the microcontroller. In addition it takes some time to have a stable crystal oscillator clock available. Therefore all functions that require a stable crystal oscillator clock are not immediately available after the wakeup.

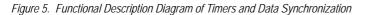
## 8.9 Baud Rate Generator

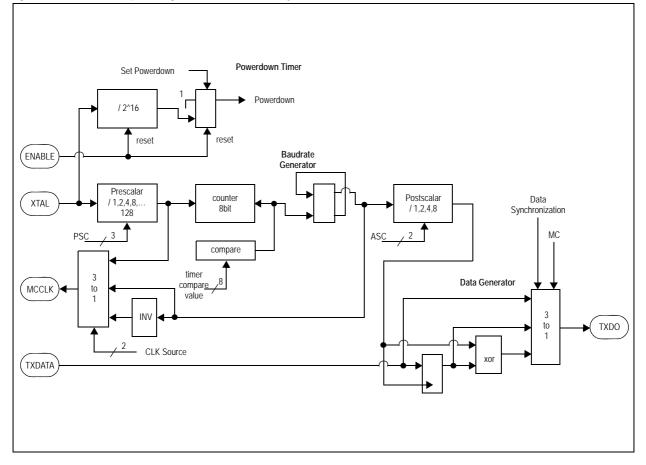
This module generates two clocks; one used for the microcontroller (MCCLK) and one as baud rate clock with 50% duty cycle. The baud rate clock is used by the microcontroller to properly synchronize the provided data during transmission with the internal Manchester coder.

The baud rate generator maintains the behavior of MCCLK and keeps it properly synchronized to the TX data clock. For example, a missing synchronization can occur when clock settings are changed by an asynchronous event like SDI programming or when a new transmission starts.

The Baud rate generator offers different types of data outputs: one fully asynchronous, one synchronous and one synchronous but Manchester coded. By means of AS3977 command control Byte, any of the three different output data types can be selected.

# 9 Application Information





The Prescaler divides the XTAL frequency by  $f_{OUT} {=} 2^{\cdot PSC {<} 2:0{>} *} f_{IN}$ 

The Compare timer divides by  $f_{OUT}=f_{IN}/(TCV+1)$  and the Postscaler divides the input frequency by  $f_{OUT}=2^{-ASC<1:0>*}f_{IN}$  which leads into a data frequency of:

$$f_{OUT=2}^{(PSC<2:0>+ASC<1:0>+1)} f_{IN} / (TCV+1)$$
(EQ 2)

# 9.1 Operation Modes

All modes are controlled by the SDI interface.

Power Down Mode

The AS3977 is connected to the power supply and can be switched to power down mode. The current consumption is limited by the leakage current.

Clock Enable Mode

In this mode, only the reference frequency generator is switched on and a clock signal is supplied via the clock output.

PLL Enable Mode

The PLL is switched on and locked at the selected output frequency. The power amplifier is in power down mode. This mode enables OOK-ASK modulation by switching the PA on and off.

Transmit Mode

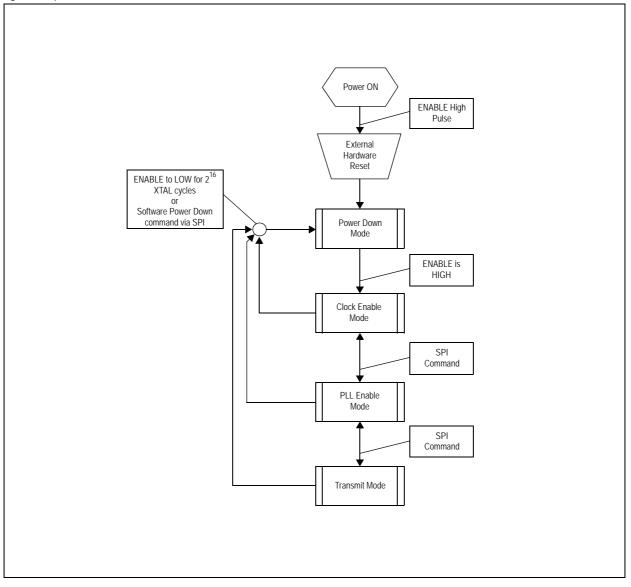
The PLL is switched on and locked at the selected output frequency. The power amplifier is in power on mode. This is the FSK mode for transmitting data.

AS3977

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Figure 6. Operation Mode Relations



## 9.2 Transmitter Control Interface

The AS3977 is controlled by an external micro controller (µC) via. a bi-directional communication interface (serial digital interface, SDI). The SDI enables data to be read from and written to internal control registers without the necessity of an internal clock signal. Analog de-bouncing of clock and data input is implemented in order to improve the overall system reliability.

The SDI-control interface includes a state machine, which expects a command control word as first byte and in reference to this byte, the interface is configured as write, read, or transmit operation. This method enables an effective and easy control of basic transmitter functions. Four preset independent output frequencies and two preset independent output power levels and modulation types can be selected using the control-command byte, thus enabling fast channel hopping and/or fast changes to the output power level and modulation type. The selection of the active output frequency and/or power level and modulation type is done using the so-called command byte.

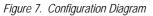
As an additional feature, the AS3977 provides a configurable clock signal derived from the crystal frequency. The purpose of this clock signal is to provide a µC clock and to enable data synchronization.

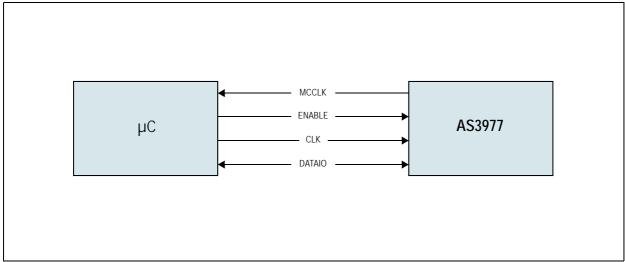
A timer is included to power down (Power Down Mode) the transmitter after a certain time, which is defined as 2<sup>16</sup> multiplied with the crystal oscillator- Period.

## 9.2.1 Configuration Diagram

The interface has one clock signal for the external  $\mu$ C and the SDI input clock. As the MCCLK line can be used to clock the SDI Interface as well as must have a high impedance pin during the clocking phase of the microcontroller, the Pin must be bi-directional. The pad behavior is selected by configuration bits and by setting the SDI DATA-IO Line of the SDI interface when leaving PD. Possible configurations between the interface and the  $\mu$ C are done using 4 wires as shown in Figure 7.

MCCLK is simply connected to the micro controller and can be used to clock a timer or interrupt logic.





A connection using a set of three wires is required to implement the SDI protocol.

- ENABLE signal is used to activate the interface and to wake up the whole IC. In addition, the rising edge of the ENABLE after power down mode is used to set the starting point of the communication protocol.
- CLK represents the SDI clock and both edges can be used for data transfer, dependable on the configuration after wake-up.
- DATAIO is a bi-directional signal that goes from microcontroller to the Interface during write and transmit-commands, while it is in the other direction when the interface is sending data read from the micro controller.

The interface supports the following functionality for the micro controller clock output (MCCLK).

- MCCLK can be inactive (MCCLK level not defined), always active after start-up (MCCLK is clocking) or clocking only during transmit.
- It is possible to configure and to maintain MCCLK settings (even when leaving PD).
- Maximum frequency is specified to f<sub>XOSC</sub> (by using the prescaler output with a division ratio of 1, PSC=0).
- Minimum frequency is f<sub>XOSC</sub> / 65280 (by using the baud rate generator output with prescaler division ratio of 128 and timer counter value of 255).

The rising edge of ENABLE after a Power Down Mode selects the transfer edge of the SDI-CLK by sampling the SDI clock value itself. This configuration will be valid until the next PD. Each bit must be transferred and sampled according to the configured edges. For example, if at the first rising edge of SDI enable SDI clock is LOW, then each bit is transferred from the microcontroller on the rising edge of SDI clock and it is sampled from AS3977 on falling edge of the SDI clock. This is valid for read as well as for write commands.

During the first byte of the WRITE command communication (command and address), the SDI master drives each new data bit on the transfer active edge and the SDI slave samples it on the next opposite edge. This protocol will be valid until the last data bit has been written to the external registers. Data' are transferred to the registers byte by byte after sampling of the last bit.

It is not necessary to enter the PD mode for reset the Interface. The rising edge of SDI-ENABLE signal starts the communication.

When the command is READ, a direction change on the SDI data wire will be done. This change has to be performed synchronously on SDI master and slave side, however, the master always provide the SDI clock. After sampling the last addressed bit, the SDI slave pin becomes active on the following SDI clock edge and the first readable bit read is transferred from SDI slave to the master.

In any case, the SDI master has to reset the SDI interface on the last bit of the data in order to stop the communication by applying an Enable

LOW pulse (duration: min > 1 SDI CLK cycle, max: < 1/f<sub>crystal</sub> \* 2<sup>16</sup>).

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## 9.2.2 Power On Reset

For stable start up of the AS3977 and to avoid unwanted crystal oscillation, it is strongly recommended to perform a power on reset (Hardware Reset Method). This can be performed as described in Table 19 and must be carried out every time when the supply voltage is less than the minimum allowed value (see Operating Conditions on page 8).

Table 19. Power On Reset

| Step  | Hardware Reset Method                             |  |  |  |
|---|---|--|--|--|
| 1   | Apply Power to the AS3977                         |  |  |  |
| 2   | Apply Enable high pulse (Low-High-Low transition) |  |  |  |
| 3 Power on reset complete after xtal start up + 2 <sup>16</sup> xtal cycles |   |  |  |  |

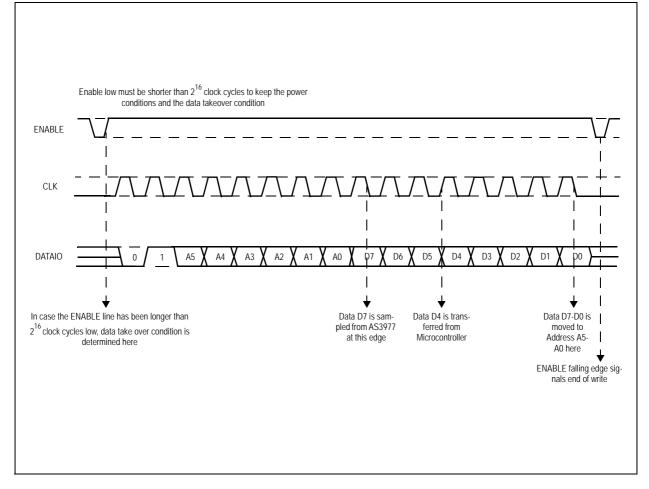
#### 9.2.3 Writing of Data to Addressable Registers

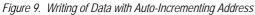
When the Power Down Mode is left, the level of CLK at the rising edge of ENABLE determines the sampling edge of CLK. If CLK is low, when ENABLE rises, DATAI is sampled at the falling edge of CLK (see Figure 8 and Figure 9), if CLK is high when ENABLE rises, DATAI is sampled at the rising edge of CLK.

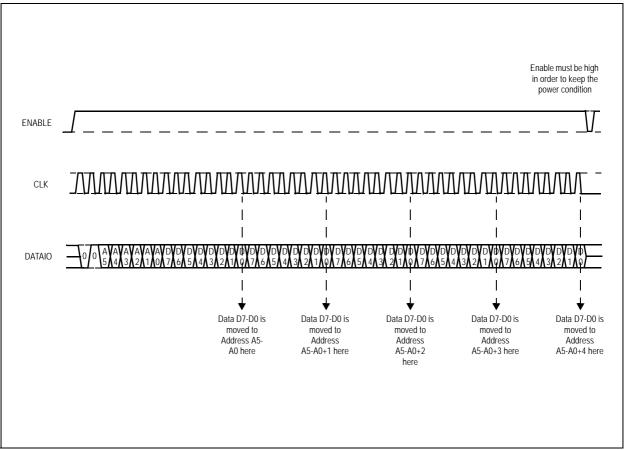
An Enable LOW pulse indicates the end of the WRITE command after register has been written.

Figure 8 illustrates a write command in which the initialization of DATAIO take over condition is done at the falling edge of CLK signal.

Figure 8. Writing of a Single Byte (falling edge sampling)







#### 9.2.4 Reading of Data from Addressable Registers

By leaving the Power Down Mode through a rising edge of ENABLE, the level of CLK determines the sampling edge of CLK. If CLK is low, DATAI is sampled at the falling edge of CLK (see Figure 10 and Figure 11), if CLK is high when ENABLE rises, DATAI is sampled at the rising edge of CLK. Consequently, data to be read from the microcontroller are driven by the slave (AS3977) at the transfer edge and sampled by the master ( $\mu$ C) at the sampling edge of CLK. An Enable LOW pulse has to be performed after register data has been transferred in order to indicate the end of the READ command and prepare the Interface to the next command control Byte.

The command control Byte for a read command consists of a command code and an address. The Command code has to be provided from least significant bit (LSB) to most significant bit (MSB), e.g. for a read it is <C0, C1> = "01". After the command code, the address of register to be read has to be provided from the MSB to the LSB. Then one or more data bytes can be transferred from the SDI slave to the master, always from the MSB to the LSB. To transfer bytes from consecutive addresses, SDI master has to keep the SDI enable signal high and the SDI clock has to be active as long as data need to be read from the slave.

Each bit of the command and address sections of the frame have to be driven by the SDI master on the SDI clock transfer edge and the SDI slave samples it on the next SDI clock edge. Each bit of the data section of the frame has to be driven by the SDI slave on the SDI clock transfer edge and the SDI master on the next SDI clock edge samples it. These edges are selected on the first access after PD and they cannot be changed until next PD.

If the read access is interrupted (by de-asserting the SDI enable signal), data provided to the master is consistent to given address, but it is only the register content from MSB to LSB. If more SDI clock cycles are provided, data remains consistent and each data byte belongs to given or incremented address.

In the following figures (Figure 10 and Figure 11), two examples for a read command (without and with address self-increment) are given. The initialization base for this timing diagram is a "LOW" on the CLK line during Initialization.

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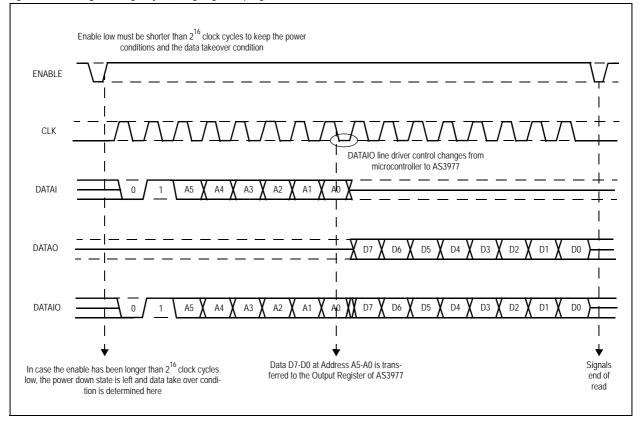
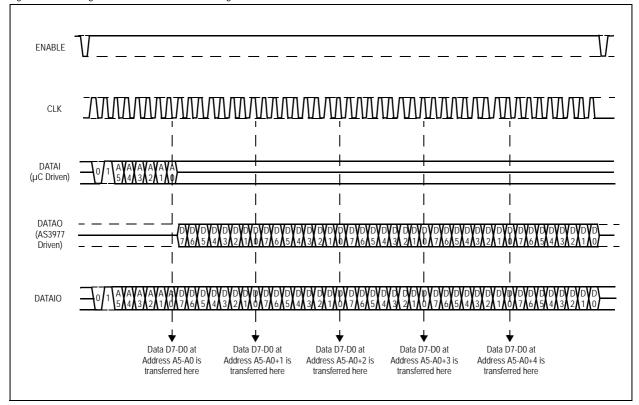


Figure 11. Reading of Data with Auto-Incrementing Address



### 9.2.5 Transmitting Data

Command code has to be provided from LSB to MSB and for transmit it is <C0, C1> = "11". After the command code, further configuration has to be provided from the MSB to the LSB. Then a bit-stream, the data to be sent, can be transferred from the SDI master by keeping SDI enable signal to high. No SDI clock is required for data synchronization or the input bit stream.

Each bit of the command and address sections of the frame have to be driven by the SDI master on the SDI clock transfer edge and the SDI slave on the next SDI clock edge samples it.

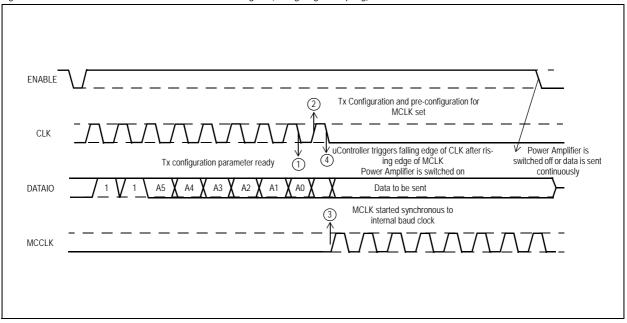
The transmission starts as follows:

After the last configuration bit has been sampled, the micro controller has to provide an additional SDI clock edge to activate the output amplifier. This allows the SDI state machine to switch to the TX status and to activate MCCLK. Then, together with the first TX data bit, the next SDI clock sampling edge provided by the master starts the transmission itself and powers on the analog output driver.

In case, the MCCLK output is properly configured, the transmission will be stopped by the microcontroller by setting the clock to a high impedance state and the MCCLK output of the Transceiver became active and takes over the communication of the Interface.

The power amplifier is switched on (if not already on) at the subsequent sampling edge of CLK after receiving the transmit command byte. This allows to delay the PAON signal, e.g. to enable locking of the PLL in case a channel hop has to be performed.

The following figure (Figure 12) shows an example (sampling falling edge) of the transmit command with MCCLK active during TX. It is important to note in this mode the sequence of events labelled 1-4 in the diagram, which lead to transmission. This mode allows the baud clock to be synchronized to the external data. In such a case, the synchronization (A5=1) bit should be set within the transmitter configuration.



#### Figure 12. Transmit Command with MCCLK Active During Tx (falling edge sampling)

## 9.3 Transmitter Control States

#### 9.3.1 Power Down State

When the Power Down Mode is entered, the crystal oscillator ends running and two very important bits of the registers are set to their inactive values:

1. Lock transmit: which is set (1) during PD to forbid any transmission.

2. Setpd: it is reset (0) to avoid a locked Power Down Mode.

When the circuit is in Power Down Mode, the crystal oscillator and all the other analog/digital circuits are OFF. The transmitter interface is the only supplied circuit and it is sensitive to SDI signals. The current consumption is limited by the leakage current. The configuration registers do not alter as long as the minimum supply requirements are met. The state can only be left by the rising edge of ENABLE. The state can be

entered either by setting the *set power down* bit (SETPD) via. SDI communication or by setting ENABLE low for more than 2<sup>16</sup> XTAL cycles (Power Down Timer). When the Power Down Mode is left (by the rising edge of ENABLE), the crystal oscillator is activated.

### Software Power Down Method.

| Step Software Power Down Method |   |  |  |
|---------------------------------|---|--|--|
| 1                               | Set power Down Bit =1 and put ENABLE to LOW level |  |  |
| 2                               | Power on reset complete with next xtal cycle      |  |  |

*Lock Transmit Bit.* When the Power Down Mode is left, the lock transmit bit (LT) is set high. The power amplifier can not be switched on as long as the bit is set to high.

| State            | ENABLE     | LT               | Description  |
|------------------|------------|------------------|--|
| Power Down Mode  | $\uparrow$ | 1                | LT is set to High  |
| All other states | 1          | LT. <sub>1</sub> | LT is unchanged except the Supply<br>voltage drops down below the<br>threshold level |

#### 9.3.2 Active Edge of CLK

When the Power Down Mode is left, the level of CLK at the rising edge of ENABLE determines the active edge of CLK (CLK polarity). Once the CLK polarity is set, it stays unchanged until the next Power Down Mode is re-entered.

| State            | ENABLE     | CLK | Description                                  |
|------------------|------------|-----|--|
| Power Down Mode  | $\uparrow$ | 0   | DATAIO is sampled at the falling edge of CLK |
| Power Down Mode  | $\uparrow$ | 1   | DATAIO is sampled at the rising edge of CLK  |
| All other states | $\uparrow$ | Х   | CLK behavior is unchanged                    |

### 9.3.3 Active State

The Active state is entered at the rising edge of ENABLE, which as well resets the Power Down timer. Possible previous states are Power Down Mode, Transmit state. DATAIO is set to SDI data input and the Interface expects a command control byte to configure the state-machine. The

SDI state can be left by programming another state or by setting ENABLE low for more than 2<sup>16</sup> XTAL cycles (Power Down timer).

#### 9.3.4 Transmit State

The state is entered upon command. The transmit command byte defines in combination with the configuration registers the transmit configuration. The power amplifier (PA) will be activated on the subsequent sampling edge of CLK after receiving the command byte only if the *lock transmit bit* has been reset (0) by a previous SDI command. Here (only here) the baud rate and data generator counters are reset, i.e. if Transmit was interrupted by a SDI communication and is re-entered again (with active PA), the baud rate generator is kept synchronized with the previous transmitted string. DATAIO is set to TX data input. If during transmit a low power reset (LPR) occurs, the lock transmit bit is set high and hence the power amplifier is switched off.

The state can be left at the falling edge of ENABLE, or increasing the Supply Voltage above the threshold and setting the register bit (LT) to zero. The control of the power amplifier is determined by the command byte (bit A4 and A5).

| State      | LT | A4 | A5 | ENABLE       | Description  |
|------------|----|----|----|--------------|--|
| All States | 1  | Х  | Х  | Х            | PAON low   |
| Transmit   | 0  | Х  | Х  | 1            | PAON high on the subsequent sampling edge of CLK after receiving the command byte            |
| Transmit   | 0  | 0  | 0  | $\downarrow$ | PAON low at the falling edge of ENABLE   |
| Transmit   | 0  | 0  | 1  | $\downarrow$ | PAON low at the falling edge of ENABLE but synchronized with<br>baud rate, DATAIO is latched |
| Transmit   | 0  | 1  | Х  | $\downarrow$ | PAON stays high, DATAIO is latched   |

Table 20. PA Control Modes



# 9.4 ENABLE Signal Functionality

Figure 21 summarizes the function of ENABLE in combination with the SDI state and the logical level of CLK and DATAIO.

Table 21. ENABLE Signal Functionality

| State            | ENABLE        | CLK | DATAIO | Description  |
|------------------|---------------|-----|--------|--|
|                  |               | Х   | Х      | resets the SDI and state machine<br>activates the crystal oscillator (PD is set to low)<br>sets the lock transmit bit  |
| Power Down Mode  | ↑             | 0   | Х      | indicates data are sampled at the falling edge of CLK  |
| r ower Down mode | I             | 1   | Х      | indicates data are sampled at the rising edge of CLK   |
|                  |               | Х   | 0      | activates MCCLK, f <sub>MCCLK</sub> =f <sub>XOSC</sub> /16   |
|                  |               | Х   | 1      | MCCLK configuration is unchanged   |
| All              | 1             | Х   | Х      | resets the Power Down Timer<br>resets the SDI Interface<br>(re-)enters the Active state                                |
| Active, Transmit | $\downarrow$  | Х   | Х      | activates the Power Down Timer; after 2 <sup>16</sup> crystal clock cycles the IC reaches the Power Down Mode          |
| Active, Transmit |               | Х   | х      | indicates the end of Read/Write<br>(duration: min > 1 SDI CLK cycle, max: < 1/f <sub>crystal</sub> * 2 <sup>16</sup> ) |
| All              | 0             | Х   | х      | disables CLK and DATAIO<br>sets DATAIO to high impedance   |
| Transmit         | $\rightarrow$ | Х   | Х      | switches off the PA (if enabled)<br>latches DATAIO (if enabled)  |

# 9.5 Communication and Command Byte Structure

A frame consists of a command byte including address/configuration and a following bit stream that can either represent an integer number of bytes or a random sequence of bits when the command is transmit. Command is encoded in the 2 first bits, while address is given on 6 bits. In case if the command is neither read nor write, these bits are used to configure the transmission and they will be stored until the next configuration.

The first byte of every SDI sequence is the command byte.

| Function | n Code | Register Address or Transmission Configuration |    |    |    |    |    |
|----------|--------|--|----|----|----|----|----|
| C0       | C1     | A5   | A4 | A3 | A2 | A1 | A0 |

The function code defines the command to be performed.

| C0 | C1 | Command   |   |  |  |  |  |
|----|----|---|---|--|--|--|--|
| 0  | 0  | Write data to register at address <a5a0></a5a0> |   |  |  |  |  |
| 0  | 1  |   | Read data from regist                         | ter at address <a5a0></a5a0>   |  |  |  |
| 1  | 0  |   | Not   | defined  |  |  |  |
| 1  | 1  |   | Transmit data. A0A5 defi                      | nes the transmit configuration:  |  |  |  |
|    |    | Bit   | Function                                      | Value, Description   |  |  |  |
|    |    | <a1, a0=""></a1,>                               | Frequency<br>Selection                        | 0 (00): selects frequency setting 1<br>1 (00): selects frequency setting 2<br>2 (10): selects frequency setting 3<br>3 (11): selects frequency setting 4   |  |  |  |
|    |    | A2  | Power level /<br>modulation type<br>selection | 0: selects power level / modulation type 1<br>1: selects power level / modulation type 2   |  |  |  |
|    |    | A3  | Manchester coding                             | 0: off<br>1: on  |  |  |  |
|    |    | A4  | PA mode                                       | <ul> <li>0: PA off at the falling edge of ENABLE (synchronized with baud rate if A5 high)</li> <li>1: DATAIO is latched at the falling edge of ENABLE (i.e. TX data are kept constant, PA stays on)</li> </ul> |  |  |  |
|    |    | A5  | Data<br>Synchronization                       | 0: off<br>1: on  |  |  |  |

# 9.6 Transmitter Configuration Register

All configuration registers are readable and writable. The registers are arranged as addressable bytes. The first byte (A<7:0>) is addressed by 0, the consecutive bytes (A<15:8>, B<7:0>, etc.) are addressed by 1,2, etc. The configuration register settings (except the registers with default setting when entering or leaving the Power down mode), do not alter during Power down mode as long as the minimum supply requirements are met.

|   |                                     | -                      |          |        |                        |           |             |                    |          |        |              |              |          |       |      |   |
|---|-------------------------------------|------------------------|----------|--------|------------------------|-----------|-------------|--------------------|----------|--------|--------------|--------------|----------|-------|------|---|
|   | 15                                  | 14                     | 13       | 12     | 11                     | 10        | 9           | 8                  | 7        | 6      | 5            | 4            | 3        | 2     | 1    | 0 |
| А |                                     |                        |          |        | PSC<br>:0>             |           |             | ARSDRS<br><1:0> LS |          |        | SEL<br>1:0>  |              |          |       |      |   |
| В |                                     | FRAC1<10               |          |        |                        | 0:0>      |             |                    | reserved | PN9INT | reserved     | SD3          | reserved |       |      |   |
| С | PLLON                               |                        |          |        |                        | INT1      | <9:0>       |                    |          |        |              | FRAC1<15:11> |          |       |      |   |
| D |                                     |                        |          |        |                        |           |             | FRAC               | 2<15:0>  |        |              |              |          |       |      |   |
| E |                                     |                        | FRAC     | 3<5:0> |                        |           |             |                    |          |        | INT2         | 2<9:0>       |          |       |      |   |
| F |                                     |                        | INT3     | <5:0>  |                        |           | FRAC3<15:6> |                    |          |        |              |              |          |       |      |   |
| G | FRAC4<11:0>                         |                        |          |        |                        |           |             | INT3<9:6>          |          |        |              |              |          |       |      |   |
| Н | rese                                | rved                   |          |        |                        |           | INT4<9:0>   |                    |          |        | FRAC4<15:12> |              |          |       |      |   |
| I |                                     |                        |          | DF<    | 7:0>                   |           |             |                    |          |        |              | GFCS         | 5<7:0>   |       |      |   |
| J | PREOP1<br><0>                       | AC AC PAOP1 RPAOV1 AT( |          |        |                        | ATCPI     | H<3:0>      |                    | reserved |        | rese         | erved        |          | REGEN | GFBP |   |
| К |                                     |                        |          |        | OP2<br>:0>             | RPA<br><1 | OV2<br>:0>  | LS                 | LT       | FSK1   |              | PREOP        | 1<4:1>   |       |      |   |
| L | PSC<br><0> CLKS<1:0> MCCDS<br><2:0> |                        |          |        | MCCS<br><1:0> reserved |           |             |                    | FSK2     |        |              |              |          |       |      |   |
| М | reserved ASC<1:0>                   |                        |          |        | <1:0>                  | TCV<7:0>  |             |                    |          | PSC    | <2:1>        |              |          |       |      |   |
| N | reserved                            |                        |          |        |                        | •         | reserved 5  |                    |          | TSRST  | TSON         |              |          |       |      |   |
| 0 |                                     |                        | reserved | 1      |                        | LD        |             |                    | TS<9:0>  |        |              |              |          |       |      |   |

Table 22. Configuration Registers

Default settings given are recommendations according to application note (not set at power up).

| Register Name       |                     | Default Value         | Description  |  |  |  |  |  |
|---------------------|---------------------|-----------------------|--|--|--|--|--|--|
| Synthesizer section | Synthesizer section |                       |  |  |  |  |  |  |
| A<1:0>              | SEL<1:0>            | application dependent | Frequency band selection<br>0 (00): 315MHz frequency band<br>1 (01): 434 MHz and ARIB frequency band<br>2 (10): 868MHz frequency band<br>3 (11): 915MHz frequency band |  |  |  |  |  |
| A<2>                | ARSRST              | 0                     | Automatic range select reset, active high  |  |  |  |  |  |

| Register | Name            | Default Value         | Description  |  |  |
|----------|-----------------|-----------------------|--|--|--|
| A<4:3>   | ARSDRS<br><1:0> | 11                    | Automatic range select division ratio setting<br>0 (00): f <sub>REF</sub> /64<br>1 (01): f <sub>REF</sub> /128<br>2 (10): f <sub>REF</sub> /256<br>3 (11): f <sub>REF</sub> /512 |  |  |
| A<7:5>   | DIVR<br><2:0>   | 010                   | Reference divider division ratio setting must be set to Binary 010   |  |  |
| A<8>     | CPSEC           | 0                     | Charge pump sections setting<br>0: One section active<br>1: Two sections active  |  |  |
| A<10:9>  | CPCS<br><1:0>   | application dependent | Charge pump current setting<br>0 (00): 12.5 μA/Section<br>1 (01): 25.0 μA/Section<br>2 (10): 37.5 μA/Section<br>3 (11): 50.0 μA/Section  |  |  |
| A<11:15> |                 | 00000                 | reserved Bits: set to Binary 00000 for normal mode o operation   |  |  |
| B<0>     |                 | 0                     | 0: normal mode of operation<br>1: reserved for test purposes only  |  |  |
| B<1>     | SD3             | 1                     | <ul> <li>ΣΔ order selection</li> <li>0: MASH2</li> <li>1: MASH3</li> </ul>   |  |  |
| B<2>     |                 | 0                     | 0: reserved Bit; set to zero   |  |  |
| B<3>     | PN9INT          | 0                     | 0: normal mode<br>1: reserved for test purposes only   |  |  |
| B<4>     |                 | 0                     | 0: normal mode<br>1: reserved for test purposes only   |  |  |
| B<15:5>  | FRAC1           |                       |  |  |  |
| C<4:0>   | <15:0>          | application dependent | Synthesizer fractional setting 1   |  |  |
| C<14:5>  | INT1<9:0>       | application dependent | Synthesizer integer setting 1  |  |  |
| C<15>    | PLLON           | 1                     | 0: Phase locked loop off<br>1: Phase locked loop on  |  |  |
| D<15:0>  | FRAC2<br><15:0> | application dependent | Synthesizer fractional setting 2   |  |  |
| E<9:0>   | INT2<9:0>       | application dependent | Synthesizer integer setting 2  |  |  |
| E<15:10> | FRAC3           |                       | Supplication fractional acting 2   |  |  |
| F<9:0>   | <15:0>          | application dependent | Synthesizer fractional setting 3   |  |  |
| F<15:10> |                 |                       |  |  |  |
| G<3:0>   | INT3<9:0>       | application dependent | Synthesizer integer setting 3  |  |  |
| G<15:4>  | FRAC4           | application dependent | Synthesizer fractional setting 4   |  |  |
| H<3:0>   | <15:0>          | application dependent | Synthesizer fractional setting 4   |  |  |
| H<13:4>  | INT4<9:0>       | application dependent | Synthesizer integer setting 4  |  |  |
| H<15:14> |                 | 00                    | reserved Bits: set to Binary 00 for normal mode of operation   |  |  |



| Register             | Name              | Default Value         | Description  |
|----------------------|-------------------|-----------------------|--|
| Modulation and Power | Amplifier section |                       |  |
| I<7:0>               | GFCS<br><7:0>     | application dependent | Gaussian filter clock setting  |
| I<15:8>              | DF<7:0>           | application dependent | FSK deviation setting  |
| J<0>                 | GFBP              | 0                     | Gaussian filter bypass<br>0: not bypassed<br>1: bypassed   |
| J<1>                 | REGEN             | 1                     | 0: Turn off the VDD RF Regulator<br>1: Turn on the VDD RF Regulator  |
| J<5:2>               | -                 | 0000                  | reserved Bits: set to Binary 0000 for normal mode of operation   |
| J<6>                 | reserved          | 0                     | reserved Bit should be set to 0  |
| J<10:7>              | ATCPH<br><3:0>    | 0000                  | Antenna tuning circuit phase shift setting<br>0 (0000): minimum capacitor<br>:<br>:<br>15 (1111): maximum capacitor      |
| J<12:11>             | RPAOV1<br><1:0>   | 11                    | PA voltage regulator setting 1<br>0 (00): VREG=1.7V<br>1 (01): VREG=1.8V<br>2 (10): VREG=1.9V<br>3 (11): VREG=2.0V       |
| J<14:13>             | PAOP1<br><1:0>    | application dependent | Power amplifier power level setting 1<br>0 (00): maximum power<br>:<br>3 (11): minimum power                             |
| J<15><br>K<3:0>      | PREOP1<br><4:0>   | application dependent | Preamplifier power level setting 1<br>0 (00000): power off<br>1 (00001): minimum power<br>:<br>31 (11111): maximum power |
| K<4>                 | FSK1              | 0                     | Modulation type selection 1<br>0: FSK<br>1: reserved for test purposes only  |
| K<5>                 | LT                | 0                     | Lock transmit, active=high   |
| K<6>                 | LS                | 0                     | Low power supply indicator, active=high  |
| K<8:7>               | RPAOV2<br><1:0>   | 11                    | PA voltage regulator setting 2<br>0 (00): VREG=1.7V<br>1 (01): VREG=1.8V<br>2 (10): VREG=1.9V<br>3 (11): VREG=2.0V       |
| K<10:9>              | PAOP2<br><1:0>    | application dependent | Power amplifier power level setting 2<br>0 (00): maximum power<br>:<br>3 (11): minimum power                             |

| Register             | Name                       | Default Value            | Description   |
|----------------------|----------------------------|--------------------------|---|
| K<15:11>             | PREOP2<br><4:0>            | application dependent    | Preamplifier power level setting 2<br>0 (00000): power off<br>0 (00001): minimum power<br>:<br>31 (11111): maximum power  |
| L<0>                 | FSK2                       | 0                        | Modulation type selection 2<br>0: FSK<br>1: reserved for test purposes only   |
| L<7:1>               | -                          | 0000000                  | reserved Bits: set to Binary 0000000 for normal mode of operation   |
| Baud Rate Generator, | Data Generator and Digital | Test Multiplexer section |   |
| L<9:8>               | MCCS<br><1:0>              | 11                       | Micro controller clock output<br>0 (00): reserved<br>1 (01): reserved<br>2 (10): Micro controller clock is on during transmit<br>(MCCLK is output)<br>3 (11): Micro controller clock is always on (MCCLK is<br>output)          |
| L<12:10>             | MCCDS<br><2:0>             | application dependent    | Clock output driver driving strength setting<br>0 (000): 4mA (maximum) driving strength<br><br>7 (111): 1mA (minimum) driving strength  |
| L<14:13>             | CLKS<1:0>                  | application dependent    | MCCLK source selection<br>0 (00): MCCLK connected to pre scaler output<br>1 (01): MCCLK connected to baud rate generator<br>output<br>2 (10): MCCLK connected to baud rate generator<br>output but inverted<br>3 (11): not used |
| L<15><br>M<1:0>      | PSC<2:0>                   | application dependent    | Micro controller clock pre scaler division ratio<br>$f_{OUT}=2^{PSC<2:0>*}$ fIN   |
| M<1.0>               | TCV<7:0>                   | application dependent    | Baud rate generator counter value   |
| M<11:10>             | ASC<1:0>                   | application dependent    | Baud rate generator extension value<br>Baud rate generator after scaler division ratio<br>$f_{OUT}=2^{-ASC<1:0>*}$ fIN  |
| M<15:12>             | reserved                   | 0010                     | reserved Bits: set to Binary 0010 for normal mode of operation  |
| Temperature Sensor s | section                    |                          |   |
| N<0>                 | TSON                       | 0                        | 0: Temperature sensor off<br>1: Temperature sensor on   |
| N<1>                 | TSNRST                     | 1                        | Reset of temperature sensor, active=low   |
| N<7:2>               | -                          | 0000000                  | reserved Bits: set to Binary 0000000 for normal mode of operation   |
| Power Down Control ( | (see Power On Reset on pa  | ge 22)                   | -   |
| N<8>                 | SETPD                      | 0                        | Set power down, active=high (see Power On Reset of page 22)   |

| Tahla 22  | Configuration | Donistors | Description |
|-----------|---------------|-----------|-------------|
| TADIE 25. | Conngulation  | Regisiers | Description |

| Register           | Name  | Default Value | Description   |  |  |  |  |
|--------------------|---|---------------|---|--|--|--|--|
| N<15:9> -          |   | 0000000       | reserved Bits: set to Binary 0000000 for normal mode of operation |  |  |  |  |
| Temperature Sensor | Temperature Sensor and Lock Detector Output (read only) |               |   |  |  |  |  |
| O<9:0>             | TS<9:0>   | -             | Temperature sensor output   |  |  |  |  |
| 0<10>              | LD  | -             | Lock detector output  |  |  |  |  |
| 0<15:11>           | -   | -             | reserved  |  |  |  |  |

# 9.7 Special Bits

The following paragraphs provide a brief description of special bits used for Transmitter Interface functionality.

## 9.7.1 LT (Lock Transmit)

The Lock Transmit bit will be set each time the circuit goes in Power Down Mode. When the bit is set, the power amplifier of the AS3977 cannot be activated. TX commands will be anyway accepted but without any "external" and visible effect.

A low has to be written before starting any RF-Transmission. The first write command can be responsible for a wake up event of the circuit and to release Power Down Mode, which will lead to the inactive state. This signal will be activated whenever the power supply is dramatically under the threshold for safe workings of analog circuits during transmit operations. If the supply voltage is under the threshold during transmit, the read back value is "1" and this can indicate a non finished transmission.

## 9.7.2 LS (Low Power Supply Voltage)

Low power Supply voltage (LS) is a read/write bit, which indicates that the power amplifier supply voltage level (VCCPA) is below a certain threshold voltage (see Table 13). After an increase of the power supply voltage above the threshold level (plus a hysteresis), this bit has to be reset to zero via SPI. The bit condition has no influence on the operation of the IC. LS and LT monitor the VCCPA supply (they are only working if Voltage is applied to VCCPA). As they are working with the same VREF generator that will be supplied from VCCPA, an overlap of the threshold levels will never occur. LS is an indicator whereby LT switches off the PA hard coded.

## 9.7.3 MCCS, CLKS and PSC

These bits are used to set the micro controller clock functionality and to control the associated MCCLK bi-directional and multi-functional pad.

MCCS stands for Micro Controller Clock output Selection and it declares how the MCCLK pad will be used. Depending on the level of DATAIO by leaving the Power Down Mode, this setting can be left unchanged from the last written value (DATAIO=1) or it can be set to the default value (DATAIO=0). Default MCCS value is "11" then the MCCLK pad is used as output and the clock is always active.

CLKS stands for Clock Selection and it is used to select as MCCLK pre-scaler or baud rate output. Default value is the pre-scaler output.

PSC stands for Pre-scaler and it is the two's exponent for first crystal oscillator division ratio. Default value is "100" that means a division ratio of  $2^4 = 16$ .

By leaving the Power Down Mode and if DATAIO is sampled LOW, these bits are set to their default values and then as soon as the crystal oscillator is on, the MCCLK will be active and with a frequency that is 1/16 of the crystal oscillator working frequency.

## 9.7.4 SETPD (Set Power Down)

This bit is used to force the circuit to go in Power Down Mode (see Software Power Down Method on page 26). When the circuit is in Power Down Mode, this bit is reset to ZERO to avoid a dead lock condition. The Power Down Mode can be reached by writing a ONE to this bit whenever a fast transition to the Power Down Mode is needed.

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# 9.8 Output Frequency Setting

The output frequency f<sub>RF</sub> is given by:

$$f_{RF} = P \cdot f_{REF} \cdot (M \cdot N + AC + FRAC) \tag{EQ 3}$$

#### Where:

P is the Predivider division ratio

 $f_{\mathsf{REF}}$  is the Reference frequency

M is the Prescaler modulus

N is the N-counter division ratio

AC is the A-counter offset, AC determines together with FRAC the actual A-counter setting

FRAC is the Fractional part

*Predivider Division Ratio P and Pre Scaler Modulus M.* The frequency band selection determines the value of the predivider division ratio P and the setting of the pre scaler modulus M. The setting of these values for the different frequency bands is given in Table 24.

Table 24. P and M Values for Frequency Bands

| Frequency Band | Р | М | BSEL<1:0> | Note          |
|----------------|---|---|-----------|---------------|
| 315 MHz        | 1 | 4 | 0 (00)    | 300 – 320 MHz |
| 433 MHz        | 1 | 5 | 1 (01)    | 425 – 450 MHz |
| 868 MHz        | 2 | 5 | 2 (10)    | 865 – 870 MHz |
| 915 MHz        | 2 | 5 | 3 (11)    | 902 – 928 MHz |

The reference frequency should be in the range of 3 to 5, 75 MHz and can be calculated by:

$$f_{REF} = \frac{f_{XTAL}}{divider} \tag{EQ 4}$$

The recommended setting of the divider is 4.

The next step is to calculate the Division ratio:

$$DR = \frac{f_{RF}}{P \cdot f_{REF}} = DR_{INT} + DR_{FRAC}$$
(EQ 5)

This division ration can be split into a part before the comma, called integer part and a part after the comma, also called fractional part DR<sub>FRAC</sub> The N-counter value of the Fractional N Synthesizer can be calculated with the formula:

$$N = whole numbered part of \frac{(DR_{INT} - 3)}{M}$$
(EQ 6)

The A-Counter is the rest of this Division and can be calculated by:

$$AC = (DR_{INT} - 3) - N \times M \tag{EQ 7}$$

In case, the Value of the A-counter is zero, the value of the A-counter has to be increased by M and the value of N has to be decreased by one

$$\begin{array}{l} AC = M \\ N = N - 1 \end{array} \tag{EQ 8}$$

In case, the N-counter is in the range from 10 to 25 and the value of the A-counter is less than N-counter-7:

$$INT < 3: 0 > = N - 10$$
  
 $INT < 7: 4 > = AC - 1$  (EQ 9)

Note: In case, no solution can be found for the wanted center frequency, it may help to modify the reference frequency or INT<8>

Data Sheet - Application Information

#### 9.8.1 Implementation

Starting from the equation,

$$f_{RF} = P \cdot f_{RFF} \cdot (M \cdot N + AC + FRAC) \tag{EQ 10}$$

The equation now rewritten by taking configuration registers and implementation details into account:

(EQ 11)

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$$f_{RF} = P \frac{f_{XTAL}}{DIVR < 2:0 > +2} \left( (INT < 9 > +4) (INT < 3:0 > + INT < 8 > 6 +10) + INT < 7:4 > +1 + (INT < 8 > +1) (3 + \frac{FRAC < 15:0 >}{2^{16}} ) \right)$$

#### Reference frequency fREF (DIVR<2:0>)

The reference frequency  $f_{REF}$  is determined by the crystal frequency  $f_{XTAL}$  and the reference divider division ratio setting DIVR<2:0> and can be calculated with the help of:

(EQ 12)

$$f_{REF} = \frac{f_{XTAL}}{DIVR < 2:0 > +2}$$

The value of f<sub>REF</sub> should be in the range of 3 MHz to 5, 75 MHz to achieve an optimum on noise performance and current consumption

$$DIVR < 2:0 > = \frac{f_{XTAL}}{f_{REF}} - 2 \tag{EQ 13}$$

# *9.8.1.1 M-counter and Value of INT<9>* The value of the M-counter is given by:

$$M = (INT < 9 > +4)$$
 (EQ 14)

The Bit INT<9> can be calculated as,

INT < 9 > = M - 4

#### 9.8.1.2 N-counter and Value of INT<3:0>

$$N = (INT < 3:0 > +INT < 8 > .6+10)$$
(EQ 15)

Taken the default value of INT<8>=0 into account, the value of the INT3<..0> can be calculated by: INT < 3:0 > = N-10

9.8.1.3 A- Counter and Value of INT<7:4>

$$AC = INT < 7:4 > +1 + (INT < 8 > +1) \times 3$$
 (EQ 16)

Taken the default value of INT<8>=0 into account, the value of the INT<7:40> can be calculated by: INT < 7:4 > = AC-1

9.8.1.4 Fractional Part and Values of FRAC<15:0>

$$DR_{FRAC} = (INT < 8 > +1) \left( \frac{FRAC < 15: 0}{2^{16}} \right)$$

Taken the default value of INT<8>=0 into account, multiplying the Fractional part with 2<sup>16</sup> gives the register values for the Fractional and synthesizer value and can be calculated by:

FRAC < 15:0 >=  $DR_{FRAC} \times 2^{16}$ 

(EQ 17)

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#### Example:

Wanted frequency 425 MHz by 16 MHz crystal frequency.

The values of P and M can be taken from table

P=1 $\rightarrow$  Defined with the BSEL Bit's BSEL<1:0>= Hex "2"

 $\mathsf{M}{=}5 \longrightarrow \mathsf{INT}{<}9{>}{=}5{-}4 = 1$ 

The Setting of DIVR<2:0> = 2 results in a reference frequency divider of 4.

The Division ratio will now be:

$$DR = \frac{f_{RF}}{P \cdot f_{RFF}} = \frac{433,92_R}{1.4} = 108,48 = DR_{INT} + DR_{FRAC}$$
(EQ 18)

And can be split into the values:

N = whole numbered part of 
$$\frac{(DR_{INT} - 3)}{M} = \frac{(108 - 3)}{5} = 21$$
 (EQ 19)

As the Rest is zero, we have to set AC=M and N to decrease by one.

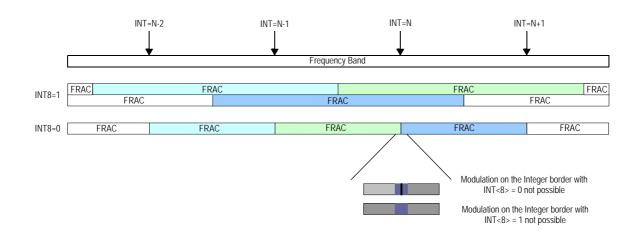
N=20 INT < 3:0 >= N-10 = 20-10=10 = Hex "A" AC=5

INT < 7:4 >= AC-1= 5-1=4 Hex "4"

FRAC < 15:0 >=  $DR_{FRAC} \times 2^{16} = 0,48 \times 65536 = 31457 = Hex "7AE1"$ 

#### 9.8.2 Optional Frequency Calculation with Overlapping Fractional Bands by Using the Bit INT<8>

**Bit INT<8>**. The bit INT<8> is a multiplier to the output of the  $\Sigma\Delta$ -modulator. Set this Bit to high stretches the fractional-N region by two and results in overlapping frequency bands with a bandwidth of 2\*f<sub>REF</sub> and an overlap ratio of 50% in order to allow frequency modulation and/or frequency trimming independently on the required output frequency and selected crystal. Note that setting INT<8> high increases the PLL inband noise by approximately 3dB. Therefore it is recommended to use this option only if the required frequency band did not fit to the crystal reference.



#### Steps for INT<8>=1

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Calculate the Division ratio

$$DR = \frac{f_{RF}}{P \cdot f_{REF}} = DR_{INT} + DR_{FRAC}$$
(EQ 20)

1. If the fractional part is larger than 0.5

$$FRAC < 15:0 > = DR_{FRAC} \cdot 2^{15}$$

N= whole numbered part of 
$$\frac{(DR_{INT} - 6)}{M}$$
 (EQ 21)

The A-Counter is the rest of the Division and can be calculated by:

$$AC = (DR_{INT} - 6) - N \times M \tag{EQ 22}$$

2. If the fractional part is less than 0.5

$$FRAC < 15:0> = (DR_{FRAC} + 1) \cdot 2^{15}$$

$$N = \text{whole numbered part of } \frac{DR_{INT} - 7}{16}$$
(EQ 23)

The A-Counter is the rest of the Division and can be calculated by:

$$AC = (DR_{INT} - 7) - N \times M$$
 (EQ 24)

In case, the value of the A-counter is zero, the value of the A-counter has to be increased by M and the value of N has to be decreased by one

М

$$\begin{array}{l} AC = AC + M \\ N = N - 1 \end{array} \tag{EQ 25}$$

In case, the N-counter is in the range from 16 to 31 and the value of the A-counter is less than N-counter-14:

$$INT < 3:0> = N - 16$$
  
 $INT < 7:4> = AC - 1$  (EQ 26)

Note: In case, no solution can be found for the wanted center frequency, it may help to modify the reference frequency or INT<8>.

#### 9.8.3 FSK Deviation Setting and Frequency Trimming

The frequency resolution  $\Delta f$  is determined by the reference frequency  $f_{REF}$ , the selected frequency band and the setting of INT<8> and can be calculated with following equation:

$$\Delta f = P \cdot (INT < 8> + 1) \cdot \frac{f_{REF}}{2^{16}}$$
(EQ 27)

#### 9.8.3.1 FSK Deviation Setting

The FSK deviation DF is given by the frequency resolution  $\Delta f$  and the setting of DF<7:0> and can be calculated with the help of:

$$DF = \Delta f \cdot DF < 5:0>$$
. DM (EQ 28)

The deviation multiplier DM is determined by the setting of DF<7:6> according to the following table:

| DF<7:6> | DM |
|---------|----|
| 0 (00)  | 1  |
| 1 (01)  | 2  |
| 2 (10)  | 4  |
| 3 (11)  | 16 |

*Frequency Trimming.* Frequency trimming (e.g. in case a characterized crystal is used) can be done with the help of the (nominal) frequency resolution  $\Delta f$  and without recalculating all the frequency settings. If the crystal error is known, the resulting error  $\varepsilon_{RF}$  in the output frequency is

also known. The ratio  $\frac{|\varepsilon_{RF}|}{\Delta f}$  can then be used to correct the error. In case the crystal error is positive,  $\frac{|\varepsilon_{RF}|}{\Delta f}$  has to be subtracted from, in case the crystal error is positive it has to be subtracted from, in case

the crystal error is negative it has to be added to FRAC<15:0>.

A similar procedure can be performed to calibrate for initial frequency errors. Note that in both cases the resulting value for FRAC<15:0> has to fulfil the conditions FRAC<15:0> - DF  $\ge$  0H and FRAC<15:0> + DF  $\le$  FFFFH.

#### 9.8.3.2 Gaussian Filter Clock Setting

The setting of GFCS<7:0> determines the clock frequency f<sub>GF</sub> of the Gaussian filter according to

(EQ 29)

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$$f_{GF} = \frac{f_{REF}}{GFCS < 7:0 > +1}$$

Ideally, f<sub>GF</sub> should be set to be 30\*f<sub>Mod</sub> (f<sub>Mod</sub> ...modulation frequency).

### 9.9 Baud Rate Generator

The main functionality of the module is to generate clocks with programmed periods. The first action is to change the parameters followed by starting a transmission.

#### Changing PSC, TCV, ASC and CLKS parameters

As soon as the crystal oscillator clock is active, pre scaler and after scaler timer configuration parameters are continuously updated from the SDI registers. To avoid spurious emissions, these synchronized values cannot be immediately used for new clock generation because the circuit has to take care about current and new clock phase difference. Then, as soon as the phase difference between them is zero, an enable signal is generated and new values are stored to the final registers that will be used for the normal functionality of the circuit. At this point the new clock will start without spurious periods.

#### Starting a transmission

A typical situation is as follows – After start up and configuration, the circuit goes in Power Down Mode. Then a wake up event occurs on the SDI interface and the internal crystal oscillator starts running (after a setup time). The wake up event is typically a rising edge on the SDI enable input that samples the SDI data e.g. to the LOW value and this resets the MCCLK frequency to be 1/16 of the oscillator frequency and makes the clock always active. At this point the micro-controller starts its activity and it can decide to reprogram MCCLK frequency to the desired value and to the desired behavior. The decision between current and new value will be done synchronously to eliminate any possible spurious period on MCCLK (mainly if it is used). In any case it can be maintained the new setting between different Power Down Modes or it can be reset to the default value on the first access to the SDI interface when the circuit is in Power Down Mode.

## 9.10 Reference Design PREOUT and PAOUT Connection

For all RF Specification, refer to the Reference Design. The PAOUT pin is Power Line matched to 50Ω load wherein a power of 8dBm@315MHz/433MHz and 4dBm@868MHz/915MHz is spent typically.

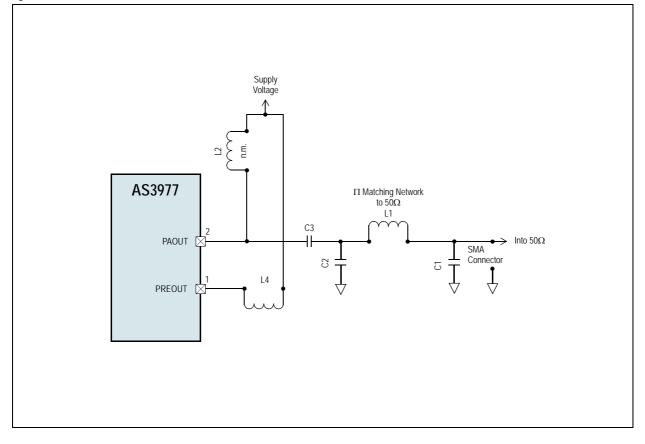
#### 9.10.1 Matching Circuit and PREOUT and PAOUT Connections to the Supply Voltage

Figure 13 shows the Power Line Matching and Transformation Network used on the Reference Design. Table 25 gives the values for several settings, varying the operation frequency and the Supply Voltage source. Supply blocking capacitors are not shown in the schematic (see Figure 13).

Data Sheet - Application Information

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#### Figure 13. Schematic



#### Table 25. Part List of the Reference Design Components

| Supply voltage 2V regulated<br>Source is VREGRF (pin 16) |        |                          | Supply voltage 3V<br>Source is Power Supply |        |                          |  |
|--|--------|--------------------------|---|--------|--------------------------|--|
| 315 MHz  |        |                          | 315 MHz                                     |        |                          |  |
| Component  | Value  | Туре                     | Compone<br>nt                               | Value  | Туре                     |  |
| L4   | 47 nH  | Murata-LQW18AN47NG00     | L4  | 43 nH  | Murata-LQW18AN43NG00     |  |
| L2   | 62 nH  | Murata-LQW18AN62NG00     | L2  | 62 nH  | Murata-LQW18AN62NG00     |  |
| C3   | 10 pF  | Murata-GRM1885C1H100JA01 | C3  | 100 pF | Murata-GRM1885C1H101JA01 |  |
| C2   | 2.7 pF | Murata-GRM1885C1H2R7CZ01 | C2  | 3.3 pF | Murata-GRM1885C1H3R3CZ01 |  |
| L1   | 56 nH  | Murata-LQW18AN56NG00     | L1  | 82 nH  | Murata-LQW18AN82NG00     |  |
| C1   | 0.5 pF | Murata-GRM1885C1HR50CZ01 | C1  | 4.7 pF | Murata-GRM1885C1H4R7CZ01 |  |
| 433 MHz  |        | 433 MHz                  |   |        |                          |  |
| L4   | 24 nH  | Murata-LQW18AN24NG00     | L4  | 24 nH  | Murata-LQW18AN24NG00     |  |
| L2   | 33 nH  | Murata-LQW18AN33NG00     | L2  | 33 nH  | Murata-LQW18AN33NG00     |  |
| C3   | 10 pF  | Murata-GRM1885C1H100JA01 | C3  | 100 pF | Murata-GRM1885C1H101JA01 |  |
| C2   | 2.2 pF | Murata-GRM1885C1H2R2CZ01 | C2  | 3.9 pF | Murata-GRM1885C1H3R9CZ01 |  |
| L1   | 43 nH  | Murata-LQW18AN43NG00     | L1  | 43 nH  | Murata-LQW18AN43NG00     |  |
| C1   | 2.7 pF | Murata-GRM1885C1H2R7CZ01 | C1  | 6.8 pF | Murata-GRM1885C1H6R8CZ01 |  |

| Supply voltage 2V regulated<br>Source is VREGRF (pin 16) |        |                          | Supply voltage 3V<br>Source is Power Supply |             |                          |  |
|--|--------|--------------------------|---|-------------|--------------------------|--|
| 868/915 MHz  |        |                          | 868/915 MH                                  | 868/915 MHz |                          |  |
| L4   | 8.2 nH | Toko-LL1608-FS           | L4  | 8.2 nH      | Toko-LL1608-FS           |  |
| L2   | 8.2 nH | Toko-LL1608-FS           | L2  | 8.2 nH      | Toko-LL1608-FS           |  |
| C3   | 10 pF  | Murata-GRM1885C1H100JA01 | C3  | 10 pF       | Murata-GRM1885C1H100JA01 |  |
| C2   | 1.0 pF | Murata-GRM1885C1H1R0CZ01 | C2  | 1.0 pF      | Murata-GRM1885C1H1R0CZ01 |  |
| L1   | 10 nH  | Murata-LQW18AN10NG00     | L1  | 10 nH       | Murata-LQW18AN10NG00     |  |
| C1   | 2.2 pF | Murata-GRM1885C1H2R2CZ01 | C1  | 2.2 pF      | Murata-GRM1885C1H2R2CZ01 |  |

# **10 Measurement Results**



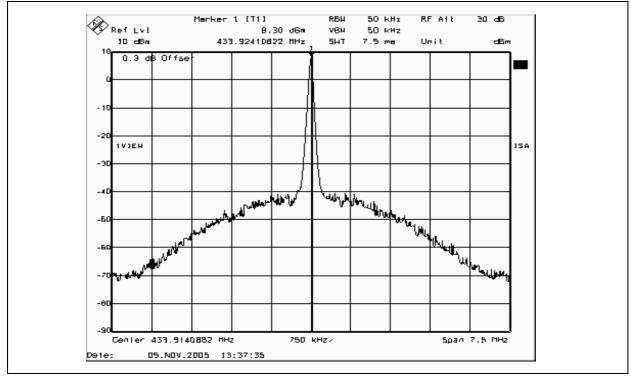
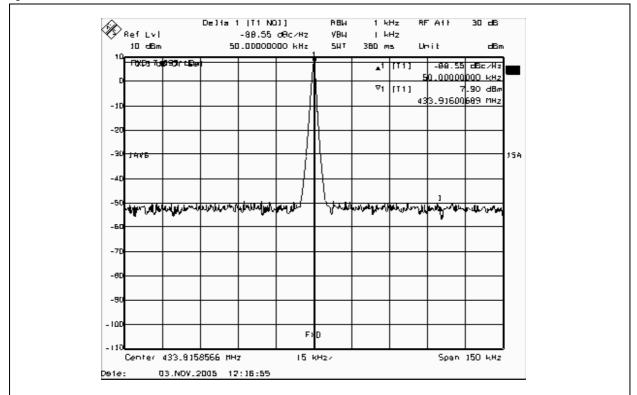


Figure 15. Phase-noise: - 88.5dBc, POUT=8dBm



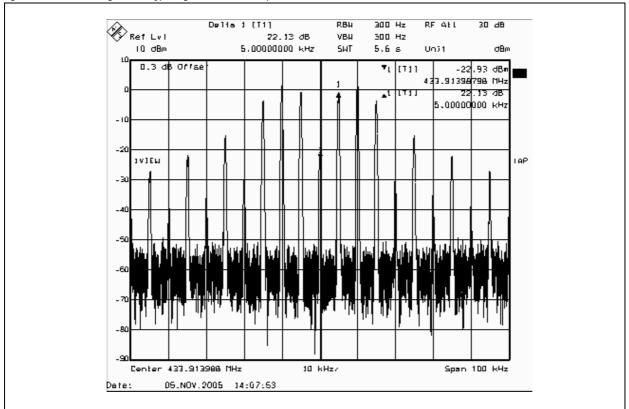
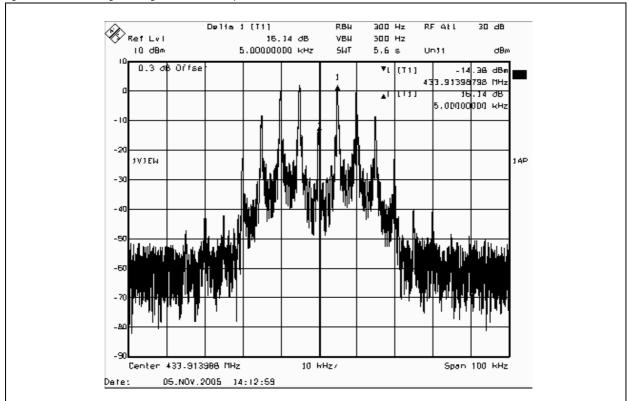


Figure 16. Modulated signal with bypass gaussian filter, Freq Mod: 5kHz, Deviation: 10kHz

Figure 17. Modulated signal with gaussian filter, Freq Mod: 5kHz, Deviation: 10kHz





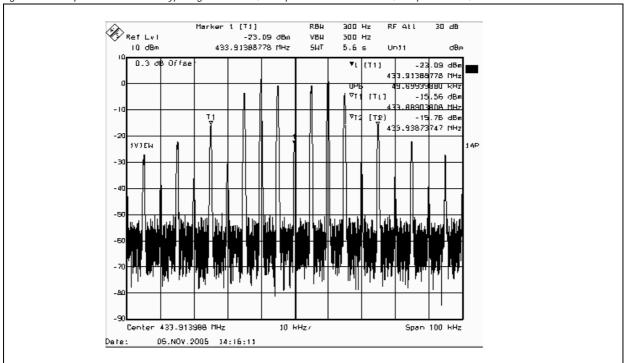
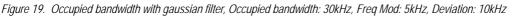
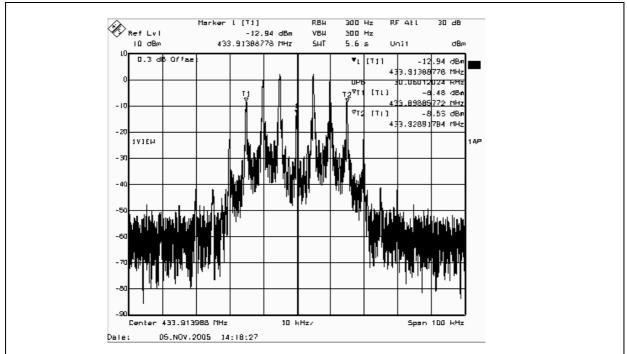


Figure 18. Occupied bandwidth with bypass gaussian filter, Occupied bandwidth: 49.7kHz, Freq Mod: 5kHz, Deviation: 10kHz





#### 10.0.1 Applicable Radio Standards

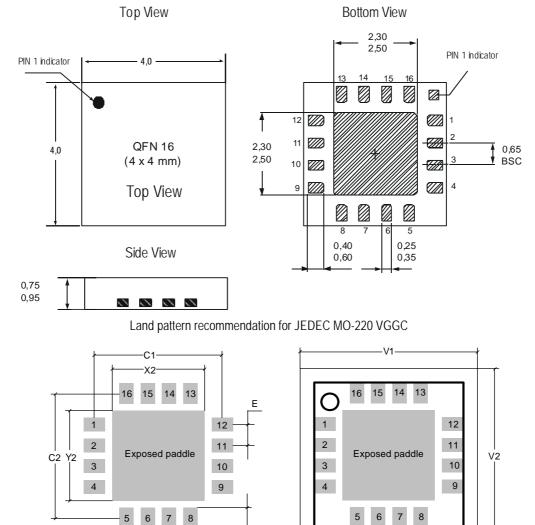
- ARIB STD-T67 (Telemeter, Telecontrol and Data-Transmission Radio Equipment)
- ETSI EN 300 220
- FCC CFR 47 Part 15

Data Sheet - Package Drawings and Markings

# 11 Package Drawings and Markings

The device is available in a 16-Lead QFN (4x4mm) package.







X1

| Symbol       | mm   |
|--------------|------|
| Pitch E      | 0.65 |
| Pad X1       | 0.35 |
| Pad Y1       | 0.9  |
| Pad Space C1 | 3.9  |
| Pad space C2 | 3.9  |
| Tab pad X2   | 2.4  |
| Tab pad Y2   | 2.4  |
| Courtyard V1 | 5.3  |
| Courtyard V2 | 5.3  |

**Y**1

# **Revision History**

| Revision | Date         | Owner   | Description  |
|----------|--------------|---------|--|
| 3.4      | Apr 01, 2008 |         |  |
| 3.5      | Dec 15, 2008 | kfr/tjs | Added block diagram Operation Mode Relations (page 20)<br>Updated Ordering Information (page 46) |
| 3.6      | Apr 16, 2010 |         | Updated Ordering Information (page 46)   |

Note: Typos may not be explicitly mentioned under revision history.

# 12 Ordering Information

The devices are available as the standard products shown in Table 27.

Table 27. Ordering Information

| Device ID  | Part Number  | Description | Delivery Form <sup>1</sup> | Package   |
|------------|--------------|-------------|----------------------------|-----------|
| AS3977-TPD | AS3977B-BQFS |             | Tray                       | QFN16 4x4 |
|            | AS3977B-BQFT |             | Tape and Reel              | QFN16 4x4 |

1. Dry Pack sensitivity Level =3 according IPC/JEDEC J-STD-033A.

#### Where:

T=Temperature range:

B=-40...85 degree P=Package Type:

QF=QFN

D=Delivery Form

S=Tray in DryPack

T=Tape and Reel

**Note:** All products are RoHS compliant and Pb-free.

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## **Contact Information**

#### Headquarters

austriamicrosystems AG Tobelbaderstrasse 30 A-8141 Unterpremstaetten, Austria

Tel: +43 (0) 3136 500 0 Fax: +43 (0) 3136 525 01

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**Телефон:** 8 (812) 309 58 32 (многоканальный) **Факс:** 8 (812) 320-02-42 **Электронная почта:** <u>org@eplast1.ru</u> **Адрес:** 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.